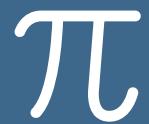


# Computer Organization & Cortex-M Architecture

Microcontroller Application and Development  
Sorayut Glomglome



# Outline

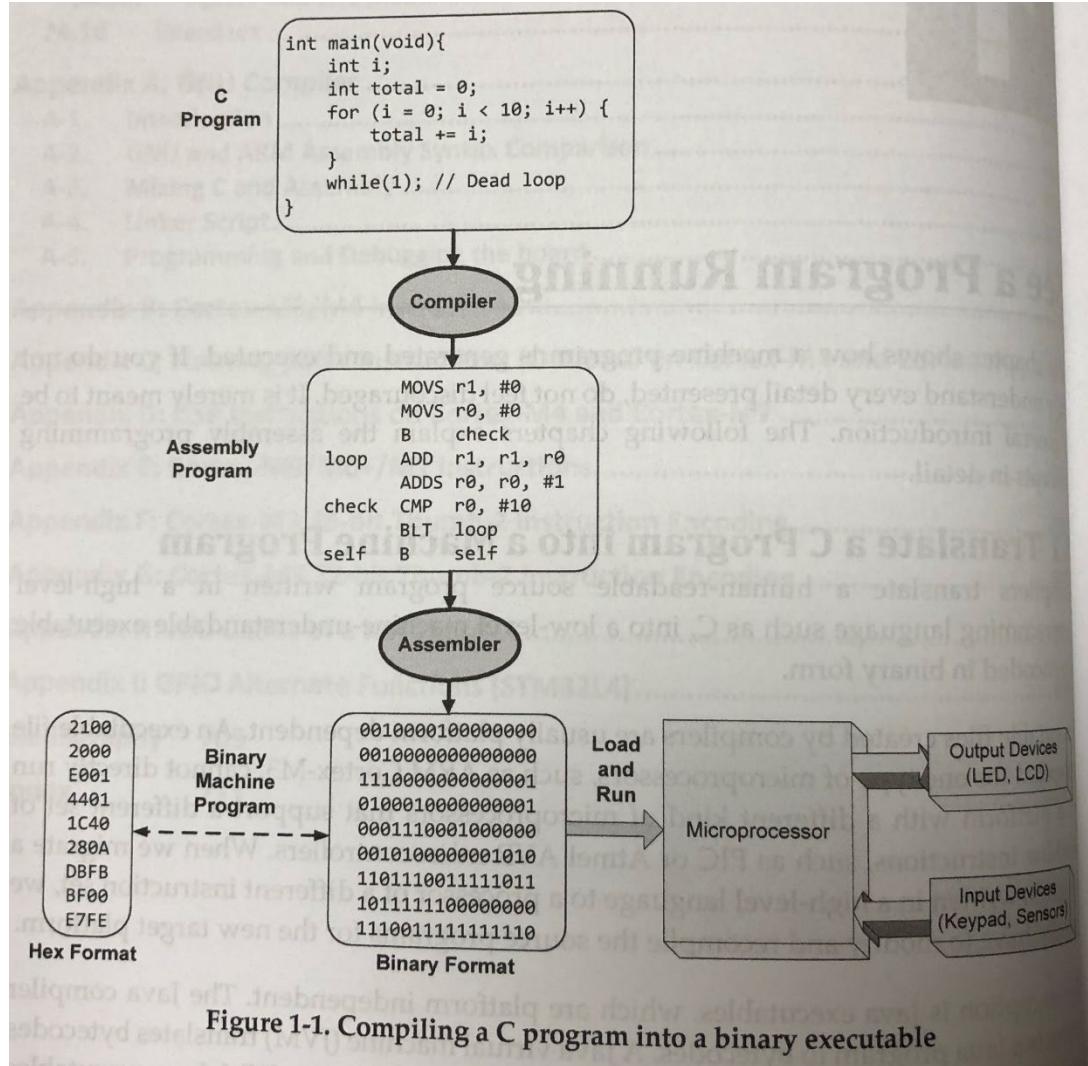
1. Computer Organization
2. Cortex M Architecture
3. Processor Registers
4. Memory Technology
5. Assembly Language

# Learning Outcome

- Understand Computer Organization
- Understand Cortex M Architecture
- Understand Basic of ARM Cortex Assembly

# การแปลภาษาสูงเป็นภาษา แอสเซมบลีและภาษาเครื่อง

- ภาษาระดับสูง (High-level language)
  - มีความใกล้เคียงกับโจทย์หรือปัญหา
  - โปรแกรมเมอร์สามารถเขียนโปรแกรมได้ง่ายและสร้างสรรค์ผลงานได้ง่ายกว่า
- ภาษาแอสเซมบลี (Assembly language)
  - คำสั่งภาษาเครื่องในรูปของตัวหนังสือ
- ภาษาเครื่อง (Machine Language)
  - ชุดของเลขฐานสองที่เรียงตัวต่อกันจำนวนเท่าของ 8 บิต เช่น 8, 16, 32, 64 บิต
  - แต่ละบิตมีค่าเป็น 0 หรือ 1 ก็ได้ โดย 0 หรือ 1 นี้จะอยู่ในรูปของระดับโวตเตจ



# Program Build Tools

## Program Build Tools

Figure 5.1 gives an overview of the build tools and the files they process to create the final executable file. Programs are built of modules that are translated through a series of formats and then combined into an executable file. The file `my_module.c` contains the module's code in the C language format. This is compiled to create an assembly language module in the file `my_module.s`, which is then assembled to create an object module in the file `my_module.o`. This module is linked with other modules (also in object format) to create the executable file.

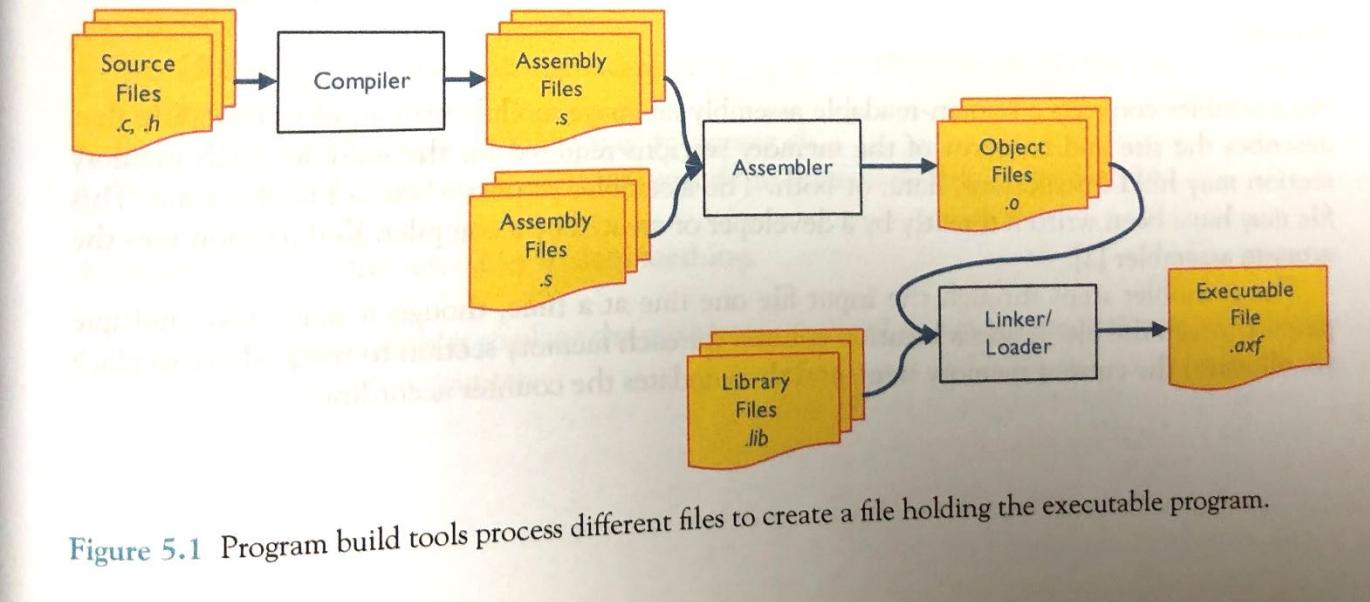
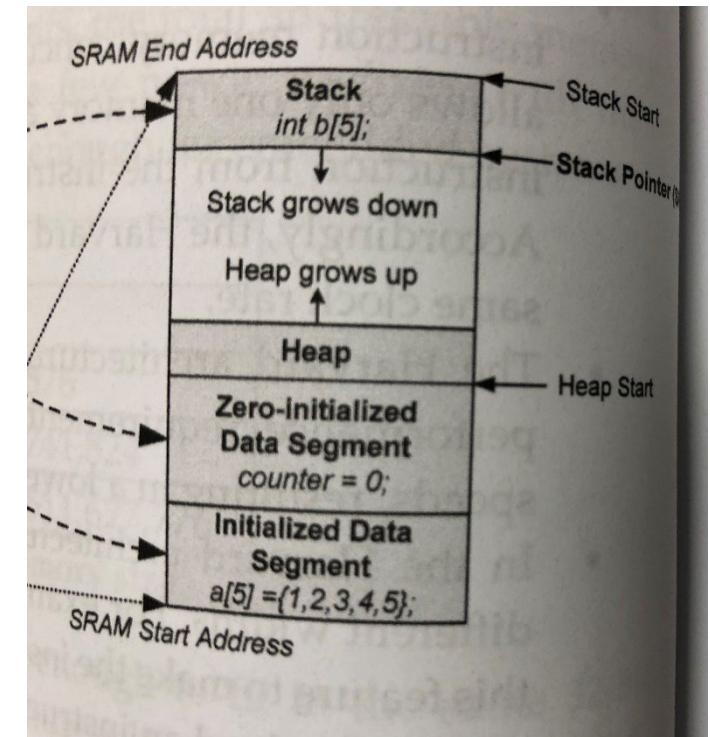
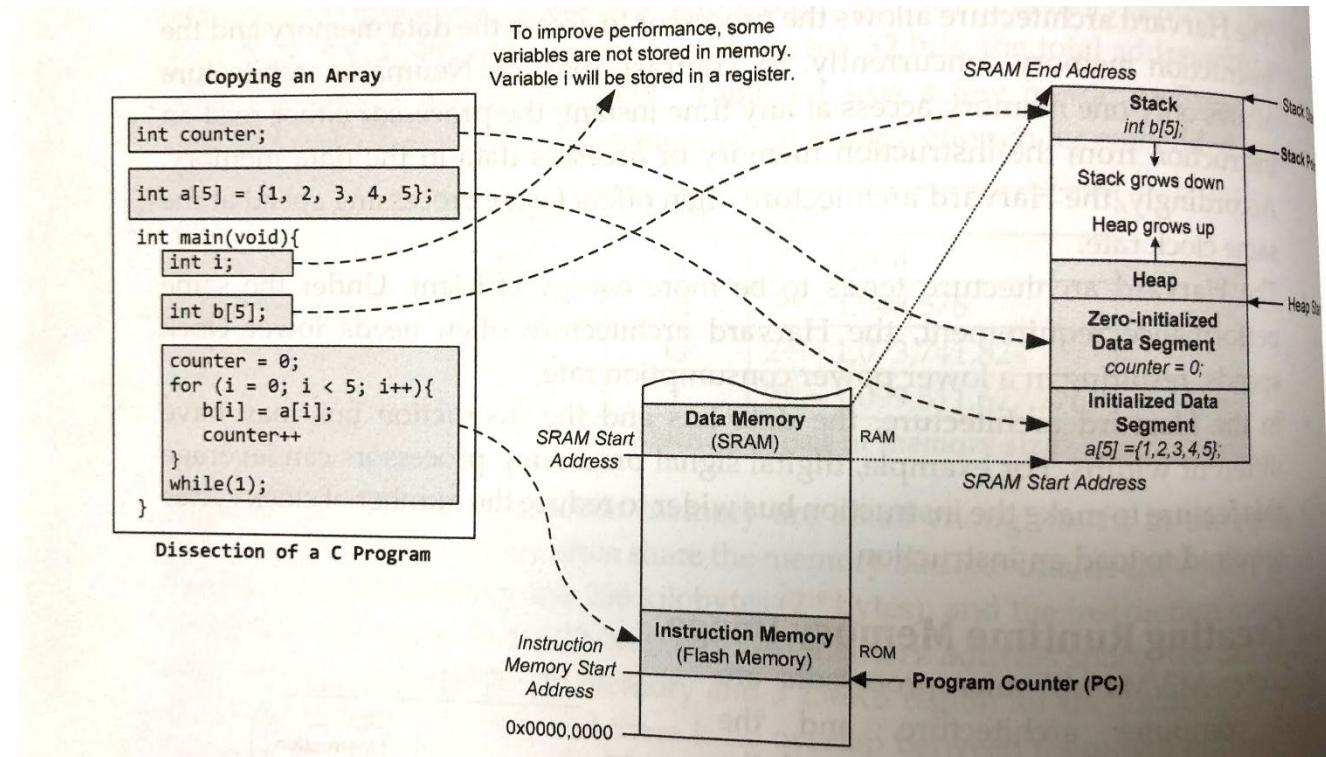
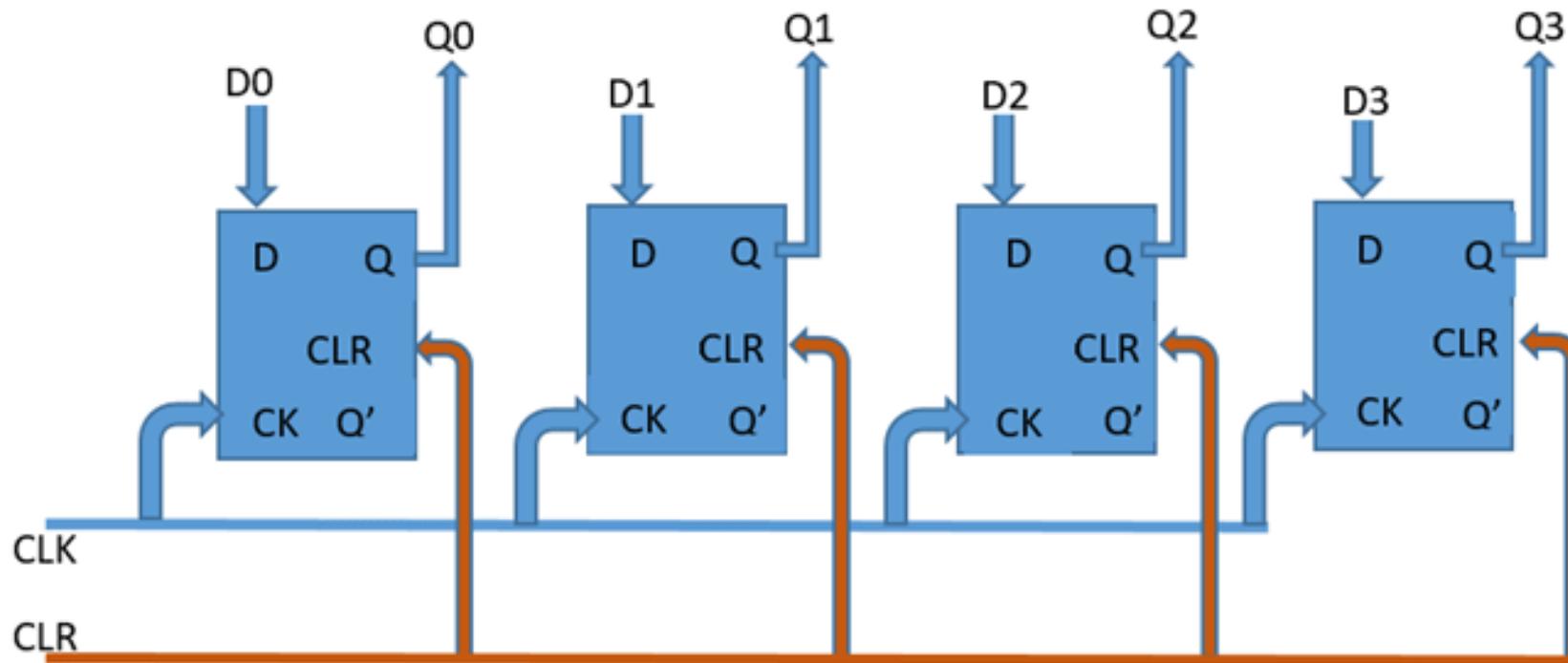


Figure 5.1 Program build tools process different files to create a file holding the executable program.

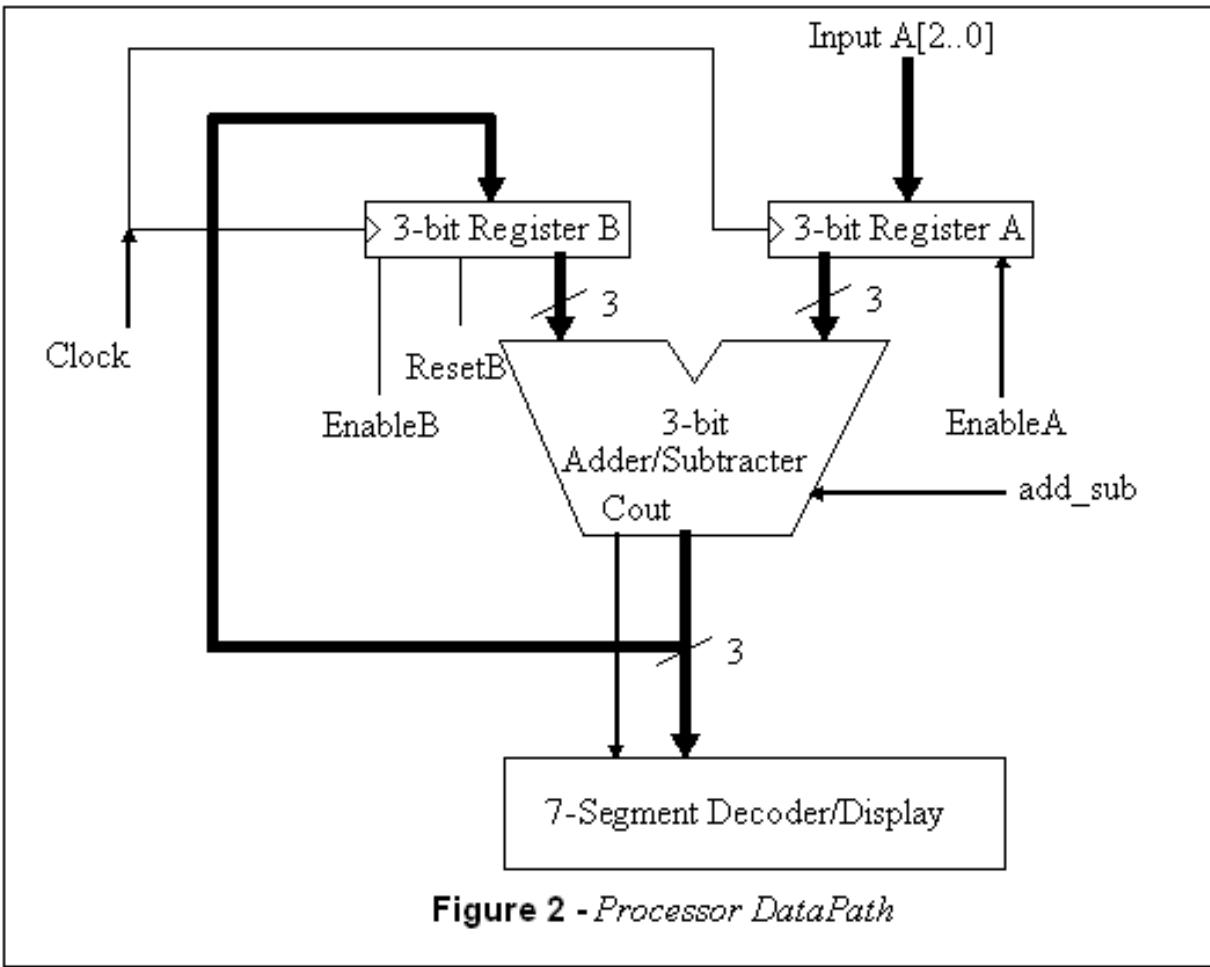
# Harvard Processor Program Loading



# 4 Bit Register from D Flip-Flop



# ALU with Registers



# Assembly Code Example 1

---

**Example 3.6:** Write code that reads from variable **N** multiplies by 5, adds 25, and stores the result in variable **M**. Both variables are 32-bit.

**Solution:** First, we perform a 32-bit read, bringing **N** into Register **R1**. Second we multiply by 5 and add 10, and lastly we store the result into **M**. Since the value gets larger, overflow could occur. This solution ignores the overflow error.

<code>LDR R3, =N ; R3 = &amp;N (R3 points to N)</code>	<code>// C implementation</code>
<code>LDR R1, [R3] ; R1 = N</code>	<code>M = 5*N+25;</code>
<code>MOV R0, #5 ; R0 = 5</code>	
<code>MUL R1, R0, R1 ; R1 = 5*N</code>	
<code>MOV R0, #25 ; R0 = 25</code>	
<code>ADD R0, R0, R1 ; R0 = 25+5*N</code>	
<code>LDR R2, =M ; R2 = &amp;M (R2 points to M)</code>	
<code>STR R0, [R2] ; M = 25+5*N</code>	

*Program 3.8. Example code showing a 32-bit multiply and addition.*

# Assembly Code Example 2

**Example 3.7:** Write code to convert a variable  $N$  ranging from 0 to 1023 into a variable  $M$ , which ranges from 0 to 3000. Essentially compute  $M = 2.93255 * N$ . Both variables are 32-bit.

**Solution:** First, we perform a 32-bit read, bringing  $N$  into Register R1. Second we multiply by 3000 and divide by 1023, and lastly we store the result into  $M$ . Since the input range is bounded ( $3000 * 1023 < 2^{32}$ ) no overflow error can occur.

<pre>LDR R3, =N      ; R3 = &amp;N (R3 points to N) LDR R1, [R3]    ; R1 = N MOV R0, #3000   ; R0 = 3000 MUL R1, R0, R1 ; 3000*N (0 to 3069000) MOV R0, #1023   ; R0 = 1023 UDIV R0, R1, R0 ; R0 = R1/R0 = 3000*N/1023 LDR R2, =M      ; R2 = &amp;M (R2 points to M) STR R0, [R2]    ; M = (3000*N)/1023</pre>	// C implementation $M = (3000 * N) / 1023;$
---	---

# Assembly Code Example 3

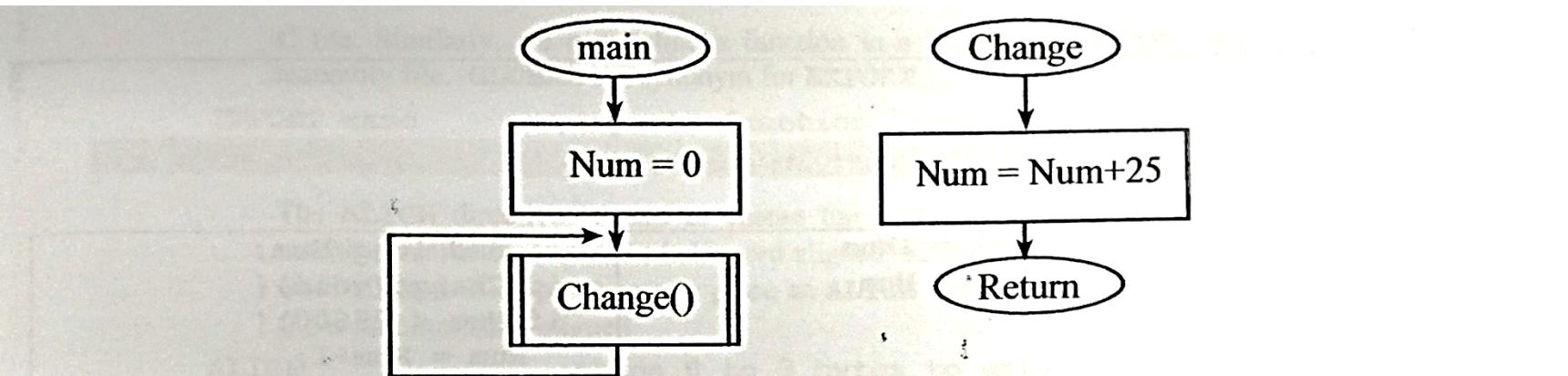


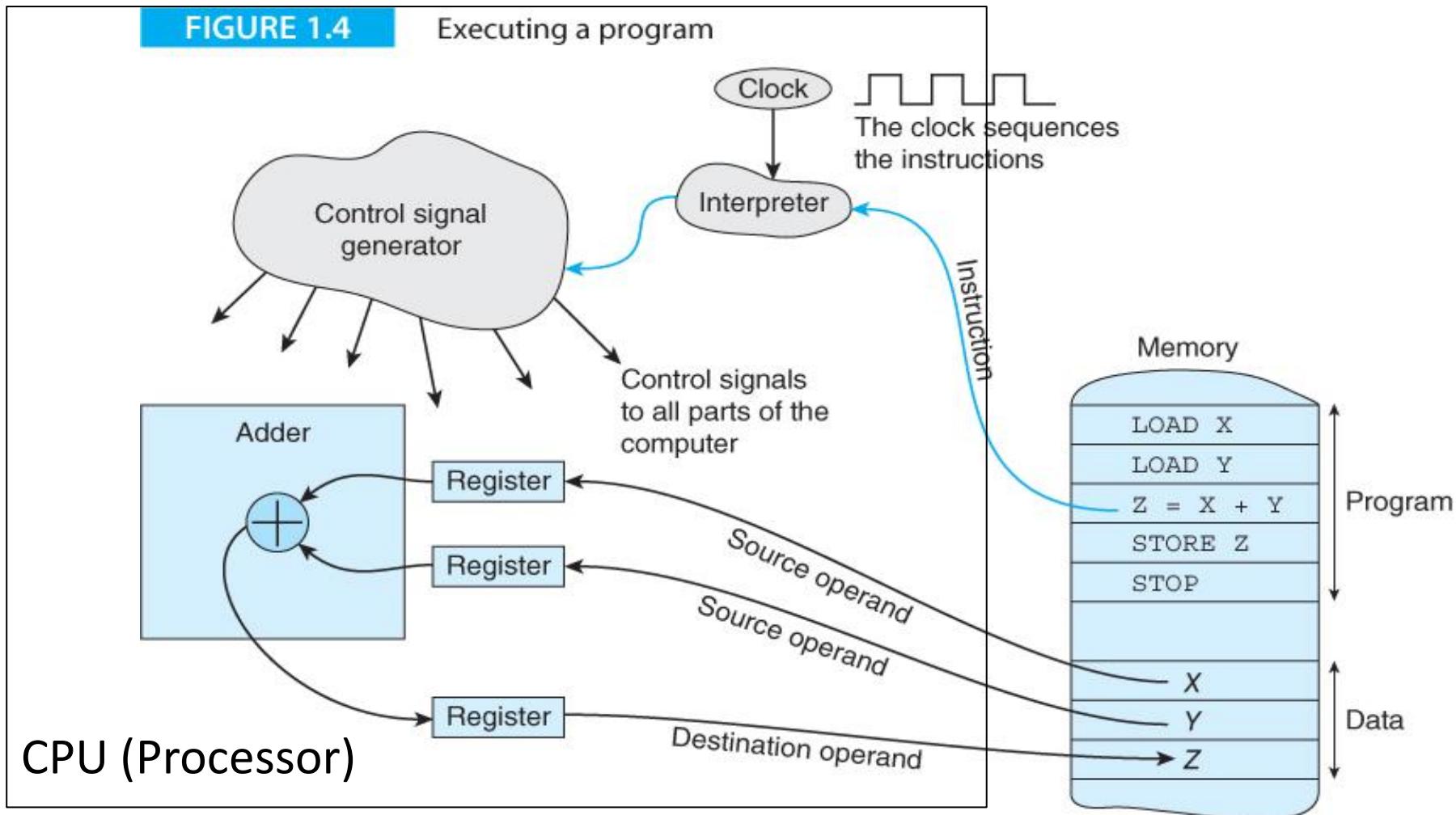
Figure 3.29. A flowchart of a simple function that generates a pseudo random number.

In C, input parameters, if any, are passed in R0–R3. If there are more than 4 input parameters, they are pushed on the stack. The output parameter, if needed, is returned in R0.

Change	LDR R1,=Num ; 5) R1 = &Num	unsigned long Num;
	LDR R0,[R1] ; 6) R0 = Num	void Change(void) {
	ADD R0,R0,#25 ; 7) R0 = Num+25	Num = Num+25;
	STR R0,[R1] ; 8) Num = Num+25	}
	BX LR ; 9) return	void main(void) {
main	LDR R1,=Num ; 1) R1 = &Num	Num = 0;
	MOV R0,#0 ; 2) R0 = 0	while(1){
	STR R0,[R1] ; 3) Num = 0	Change();
loop	BL Change ; 4) function call	}
	B loop ; 10) repeat	}

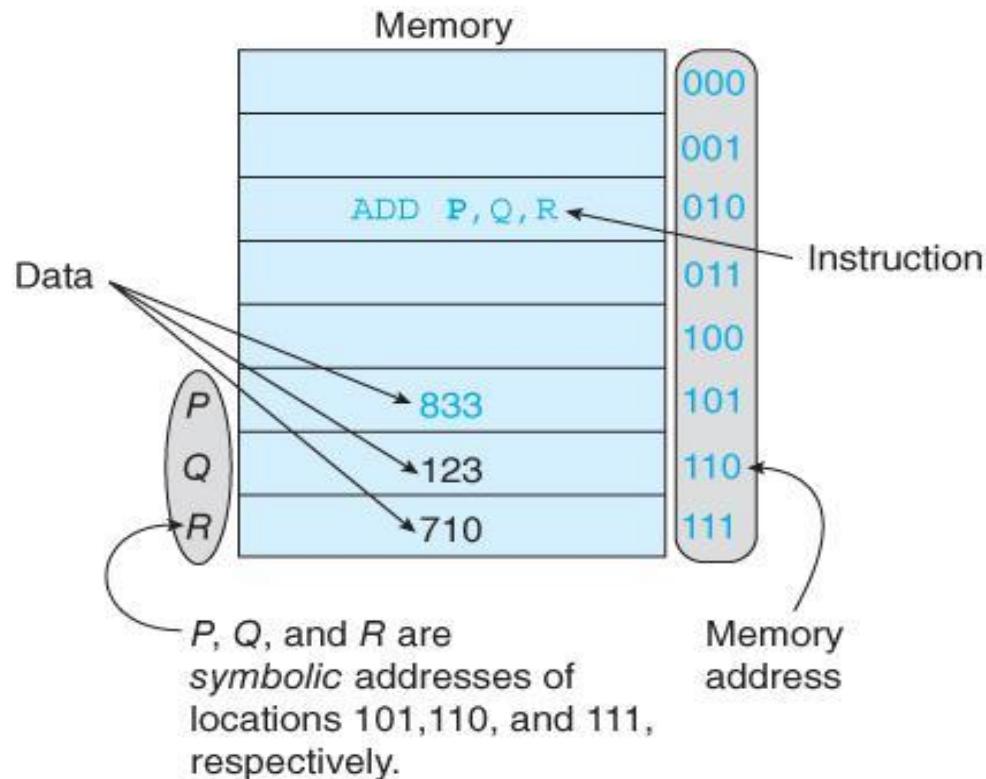
Program 3.9. Assembly and C versions that define a simple function. The 1-2-...-10 show the execution sequence.

# How software orders CPU (Processor) to run



# Memory System stores Software/Data

**FIGURE 1.13** Relationship between instruction and operands



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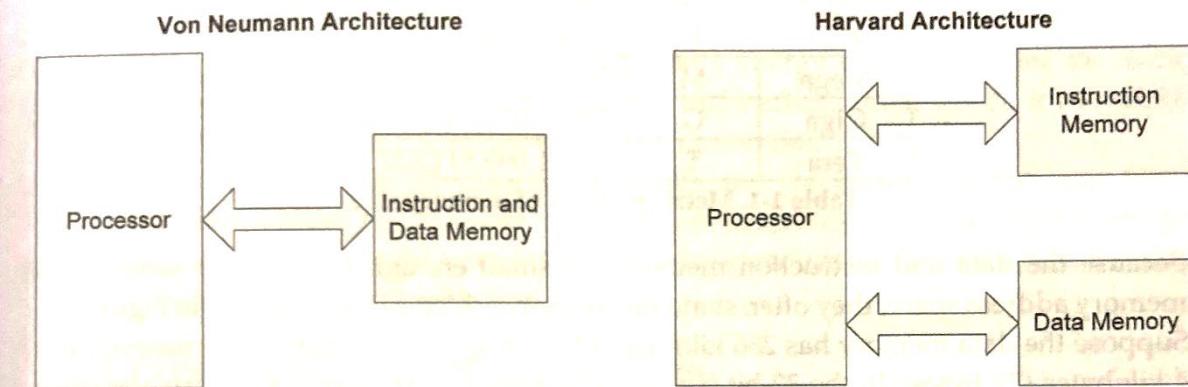


Figure 1-3. Two types of computer architecture. In the Von Neumann architecture, data and instructions are stored in the same memory. In the Harvard architecture, data and instructions are stored in two physically separate memory devices.

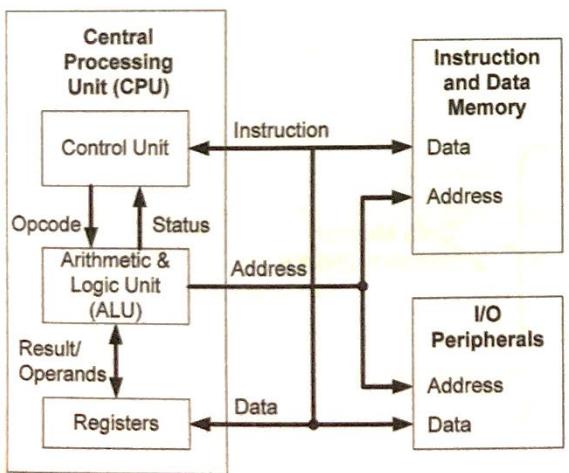


Figure 1-4. Von Neumann computer architecture. Instructions and data share the memory device. It has only one set of data bus and address bus shared by the instruction memory and the data memory.

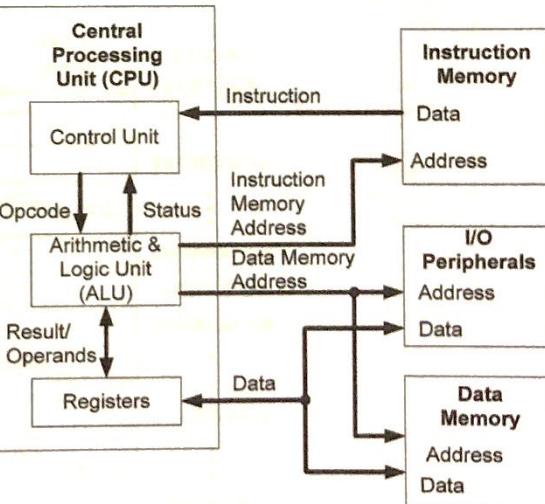
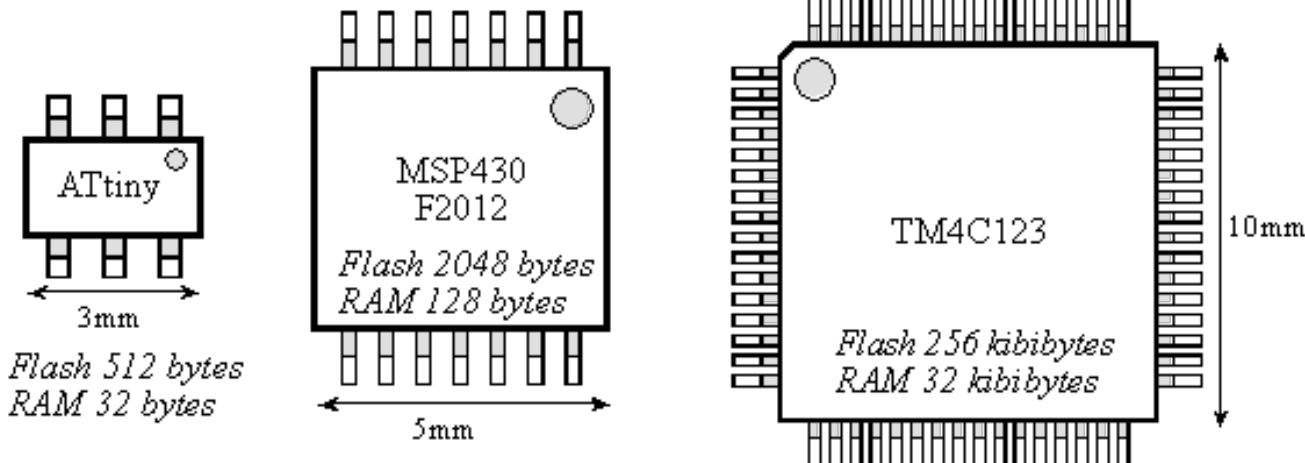


Figure 1-5. Harvard computer architecture. Instructions and data are stored in different memory devices. It has a dedicated set of data bus and address bus for the instruction memory and the data memory.

# Von Neumann VS Harvard Architecture

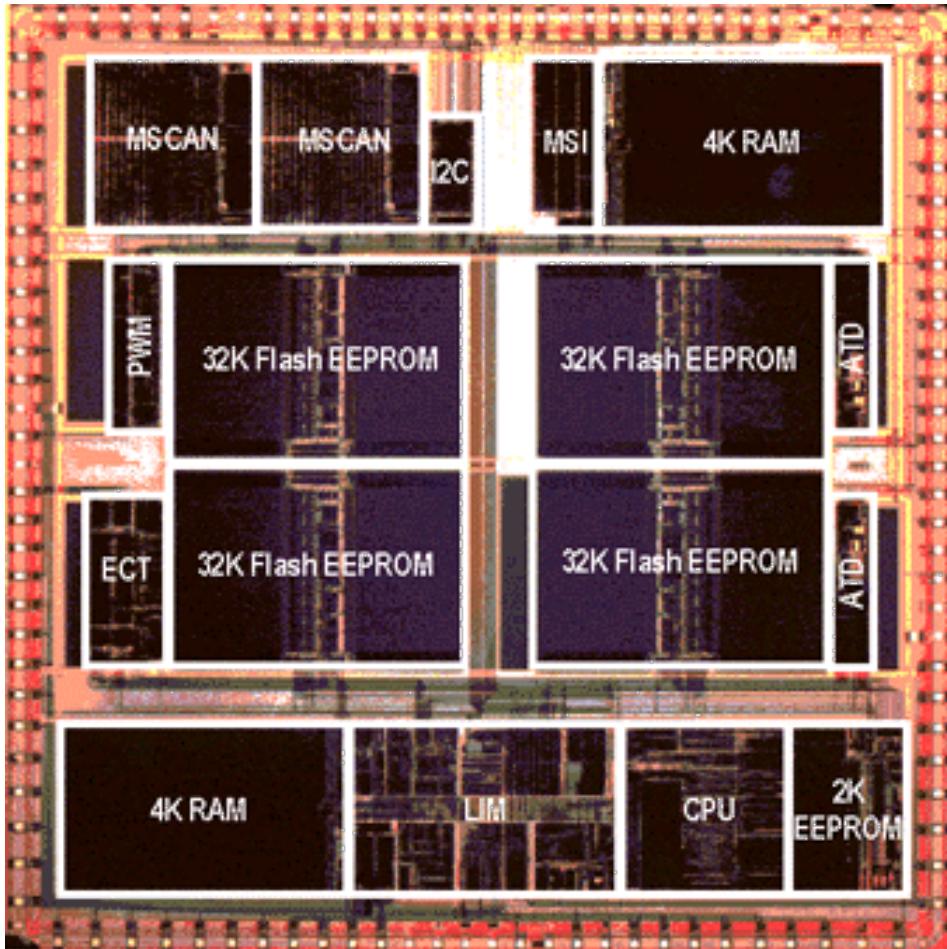
# Microcontroller

- A complete computer on a single chip
  - Processor
  - Memory
  - I/O



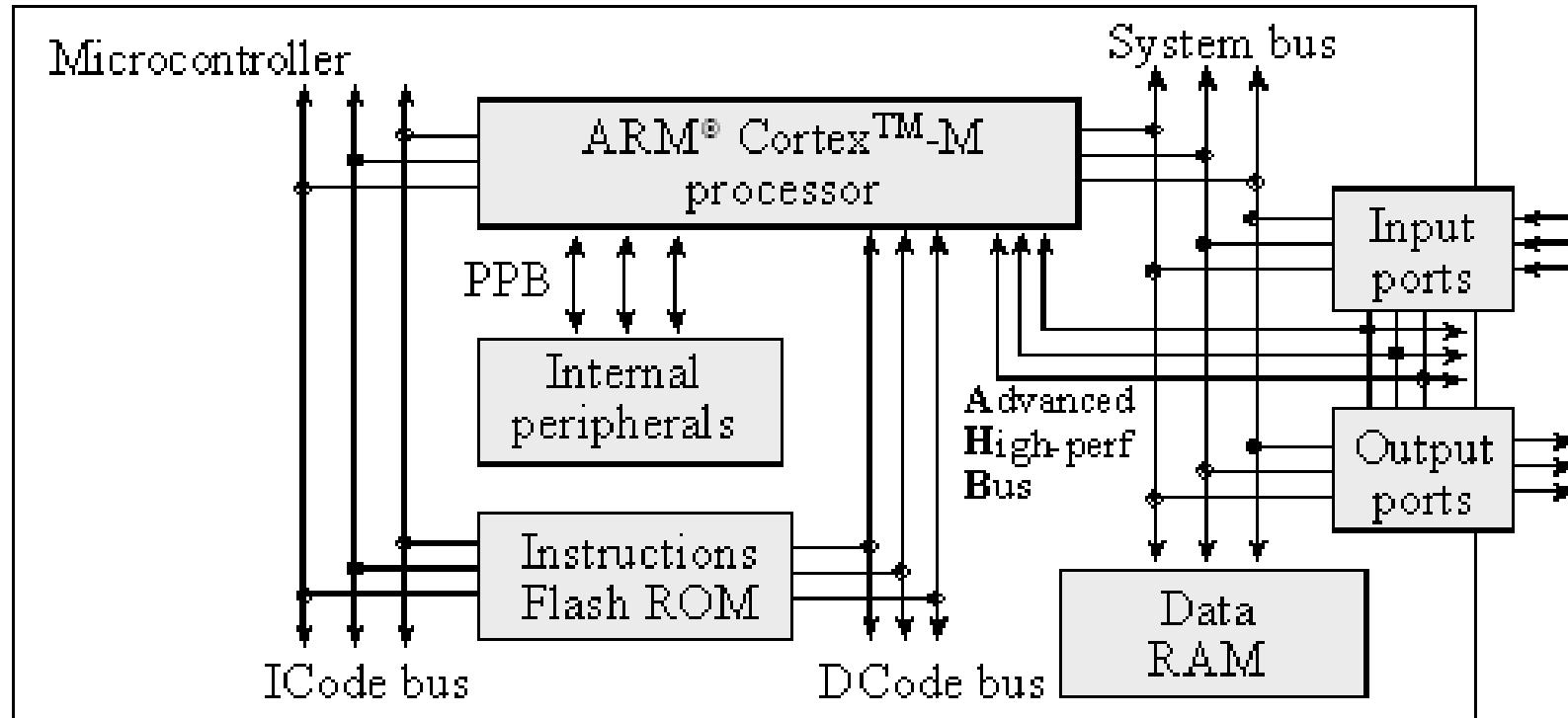
# A Photo of MCU Die

- 128K Flash EEPROM
  - 4 x 32K
- 8K RAM
  - 2 x 4K
- 2K EEPROM

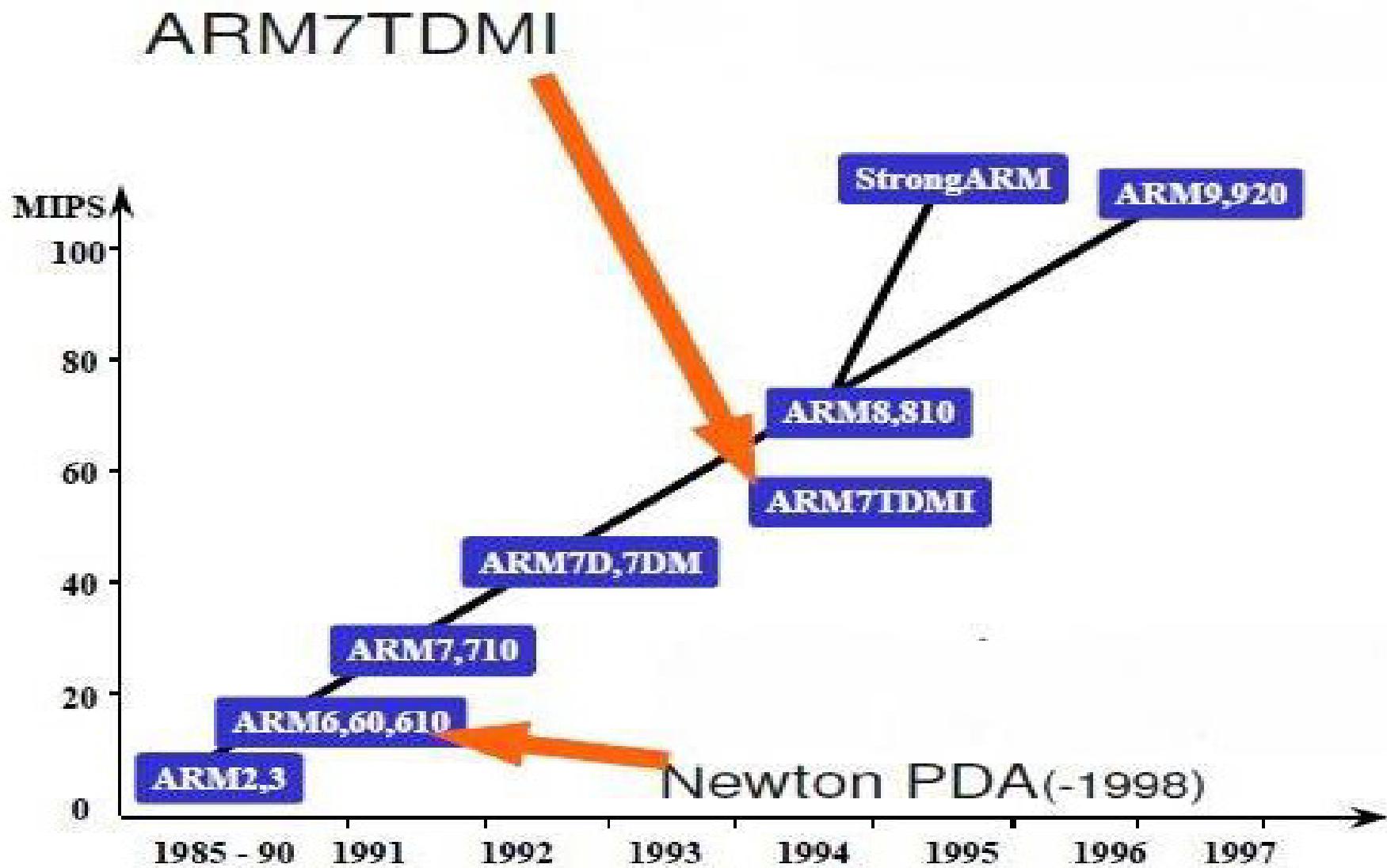


# ARM Cortex Architecture

- Harvard architecture
  - Separate instructions and data



# *ARM History*



# Arm Processors

## ARM Architecture: For Diverse Embedded Processing Needs

### Cortex - A

Highest performance

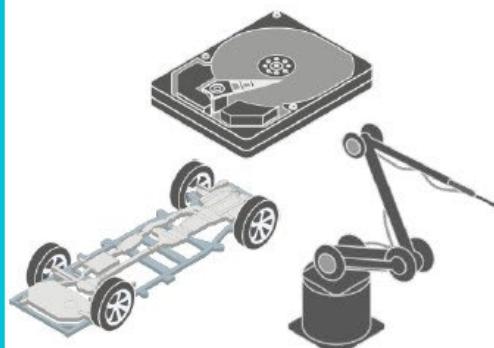
Optimised for  
rich operating systems



### Cortex - R

Fast response

Optimised for  
high performance,  
hard real-time applications



### Cortex - M

Smallest/lowest power

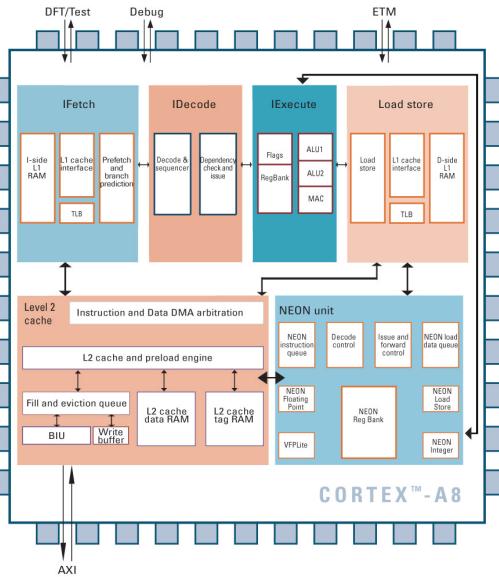
Optimised for  
discrete processing and  
microcontrollers



# Cortex family

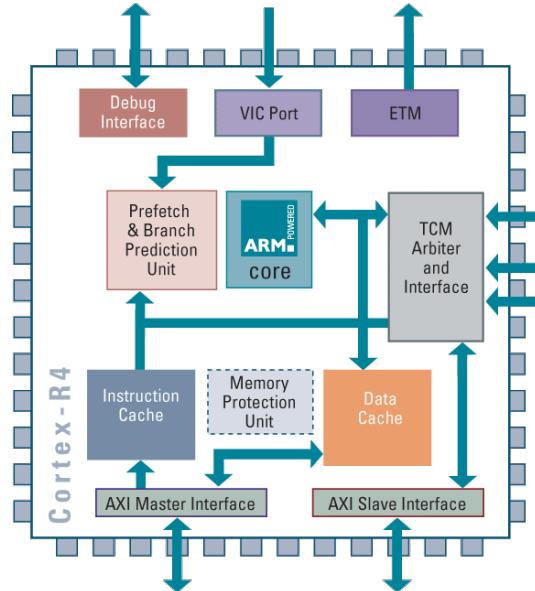
## Cortex-A8

- Architecture v7A
- MMU
- AXI
- VFP & NEON support



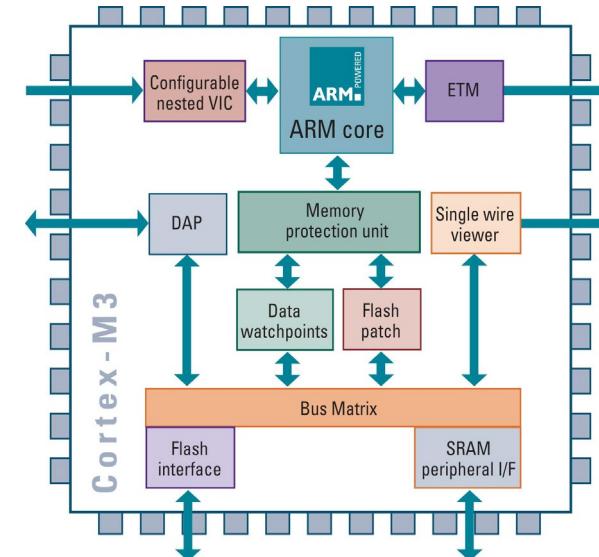
## Cortex-R4

- Architecture v7R
- MPU (optional)
- AXI
- Dual Issue

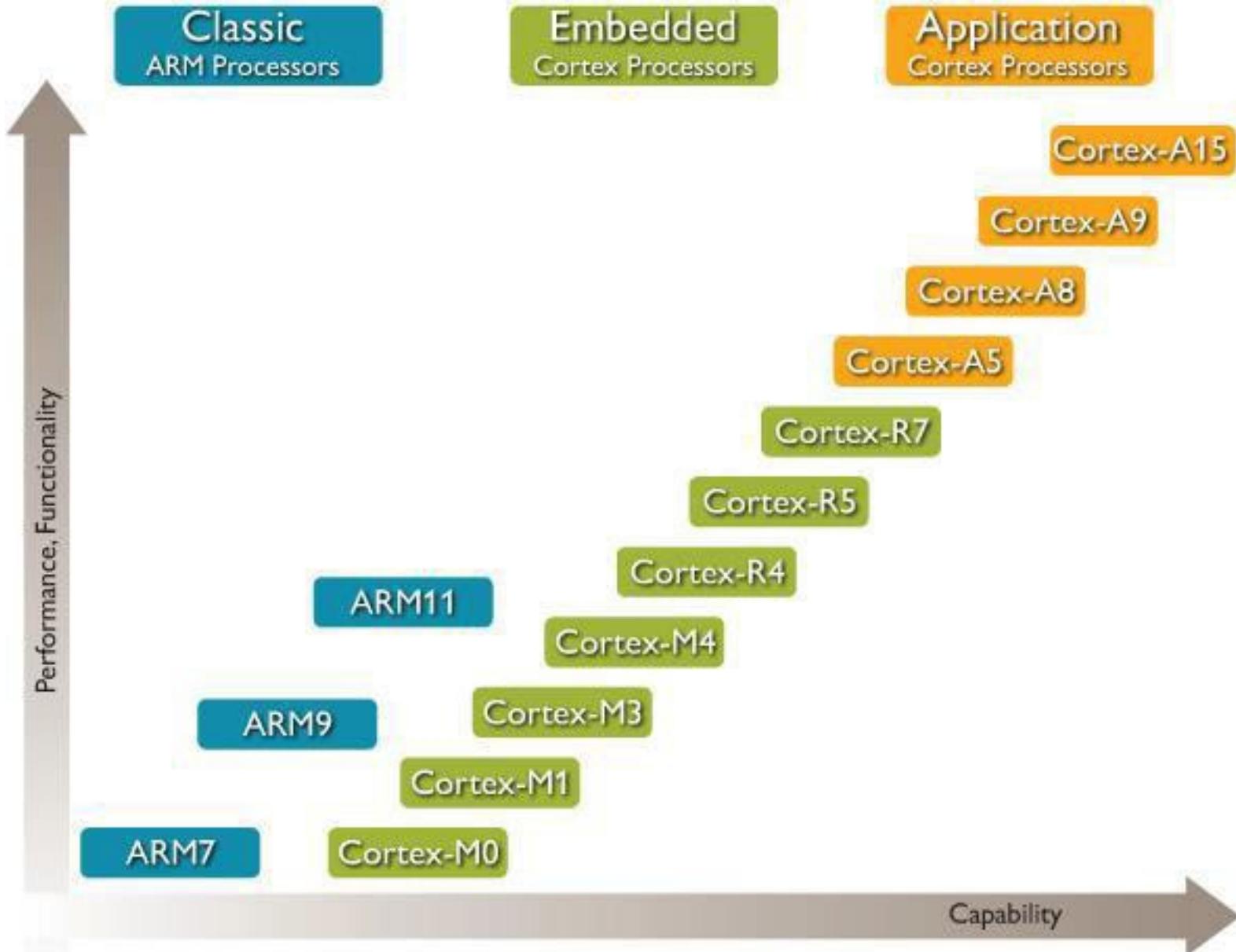


## Cortex-M3

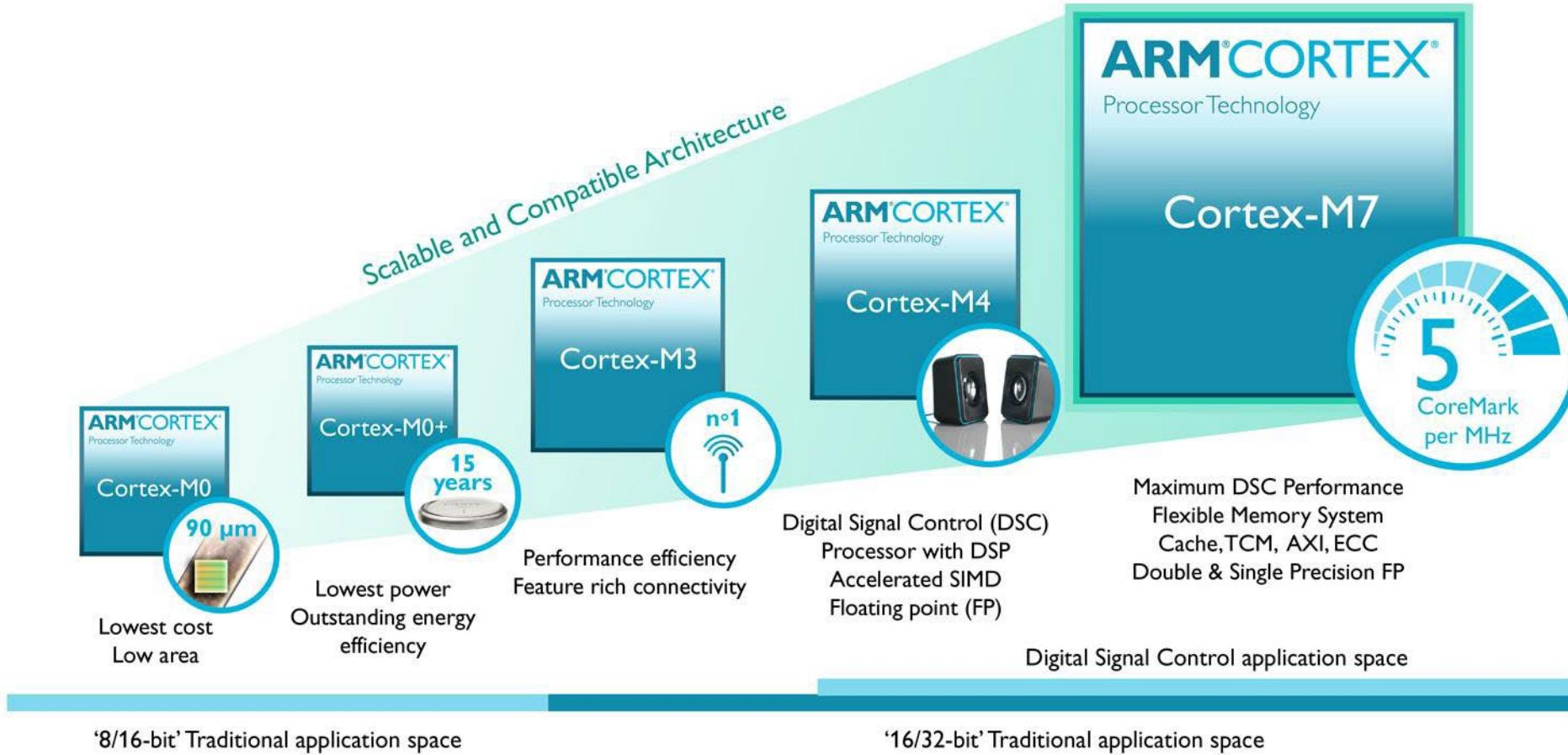
- Architecture v7M
- MPU (optional)
- AHB Lite & APB



# *Arm Processors*

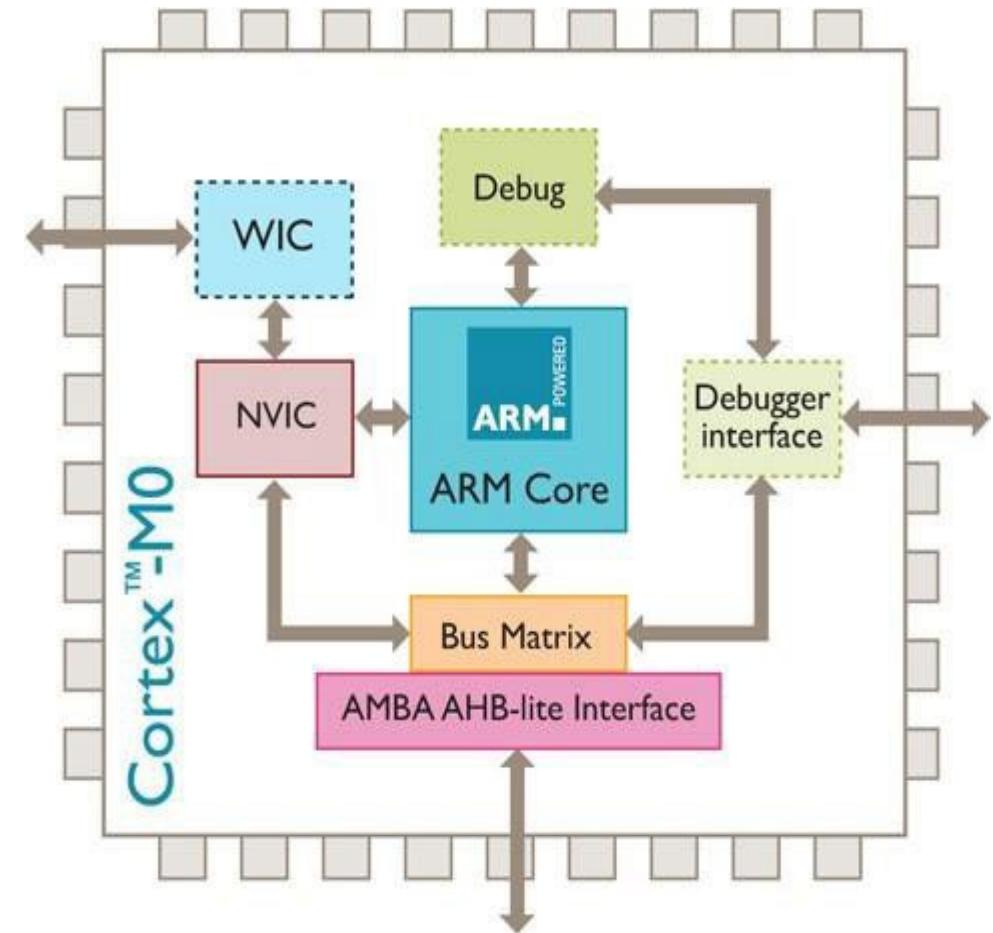


# Cortex -M Processors



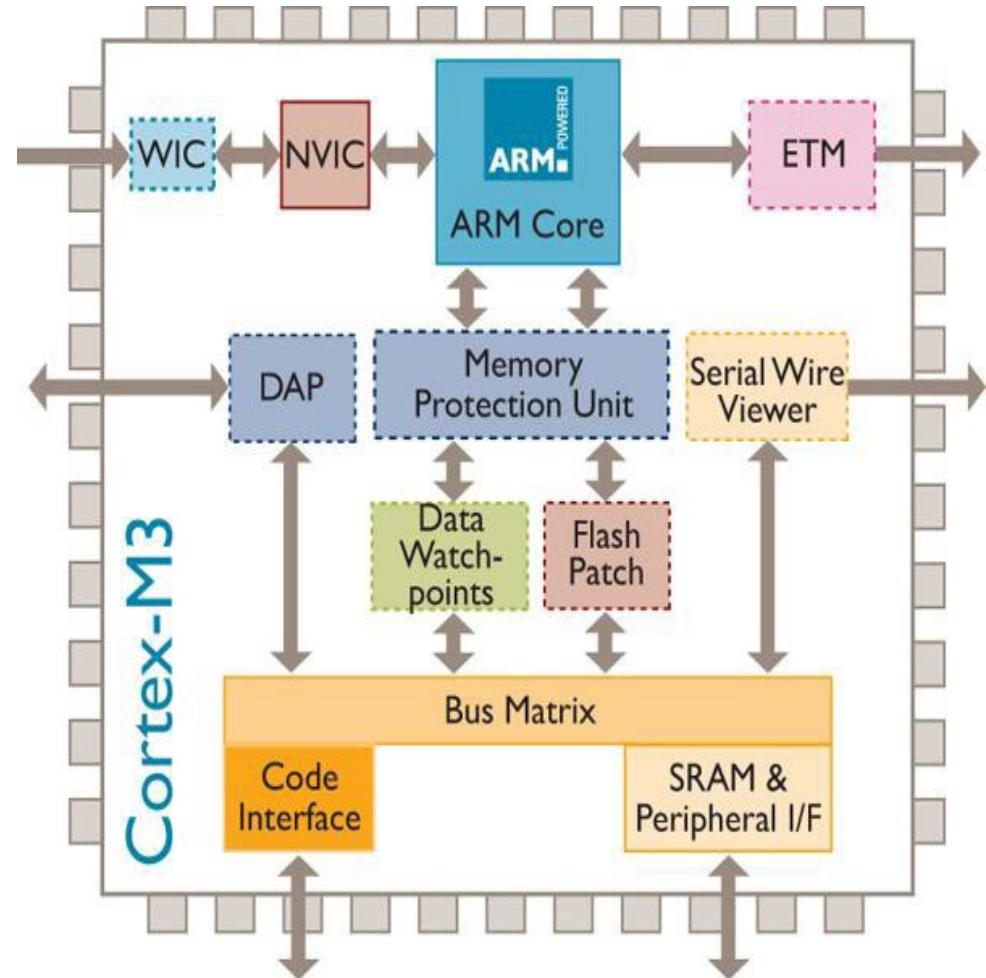
# Embedded ARM Cortex Processors

- Cortex M0:
  - Ultra low gate count (less than 12K gates).
  - Ultra low-power ( $3 \mu\text{W}/\text{MHz}$  ).
  - 32-bit processor.
  - Based on ARMv6-M architecture.



# Embedded ARM Cortex Processors

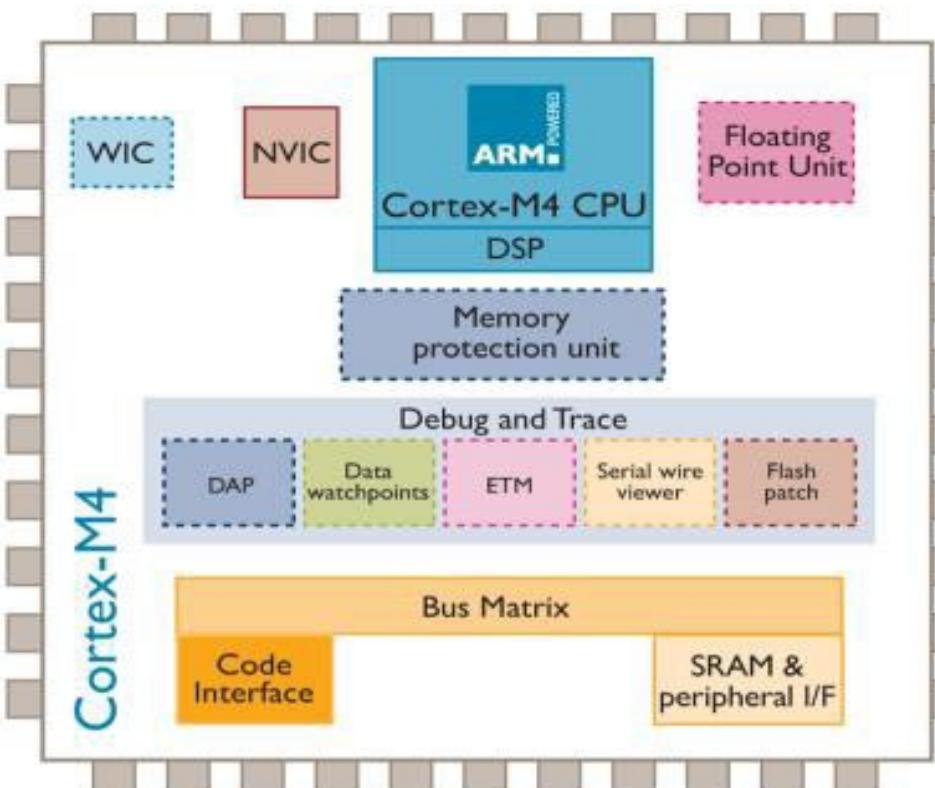
- Cortex M3:
  - The mainstream ARM processor for microcontroller applications.
  - High performance and energy efficiency.
  - Easy migration path from FPGA to ASIC.
  - Advanced 3-Stage Pipeline.
  - Based on ARMv7-M architecture.



# Embedded ARM Cortex Processors

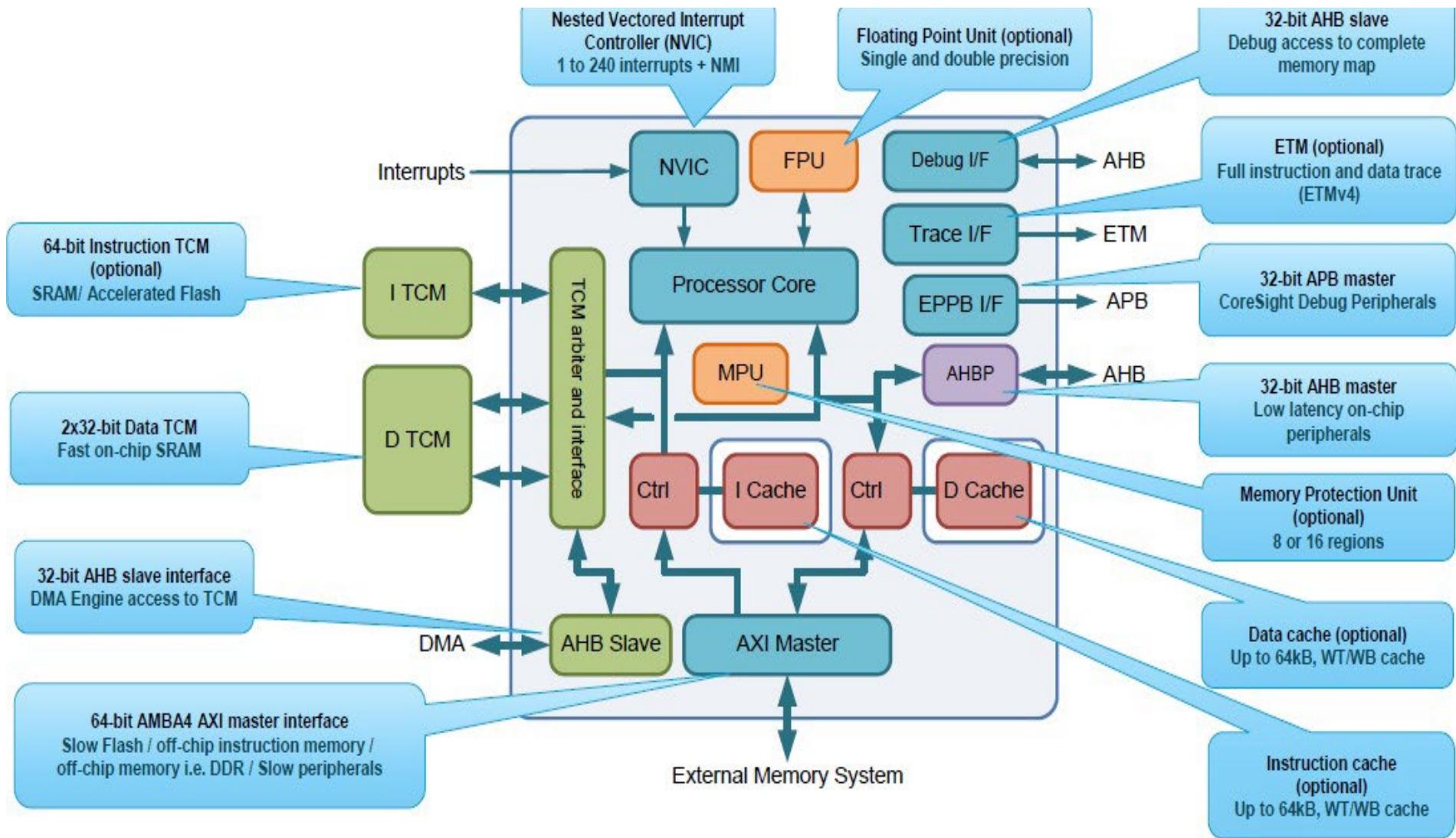
- Cortex M4:

- Embedded processor for DSP.
- FPU (Floating Point Unit).
- Based on ARMv7E-M architecture.



# Cortex M7

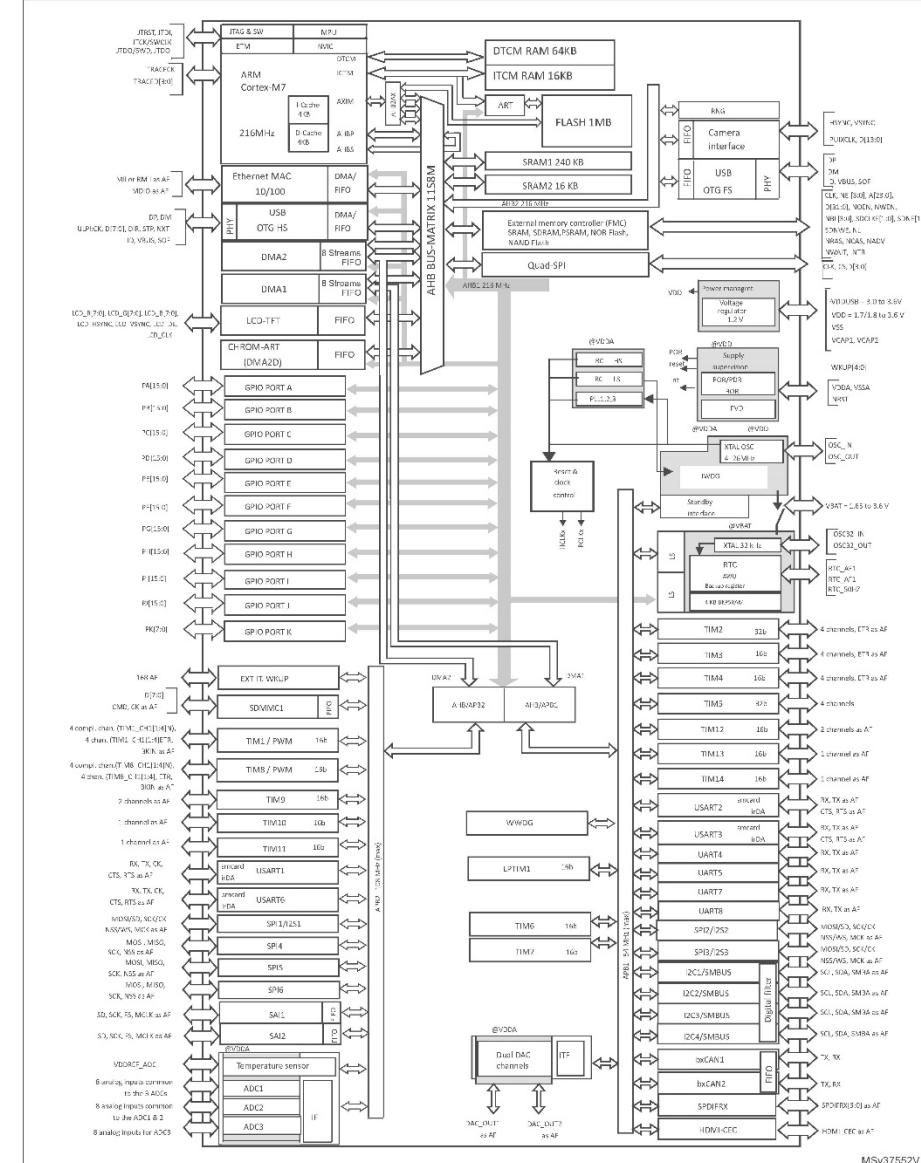
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# STM32F746NG Block Diagram

Figure 2. STM32F745xx and STM32F746xx block diagram

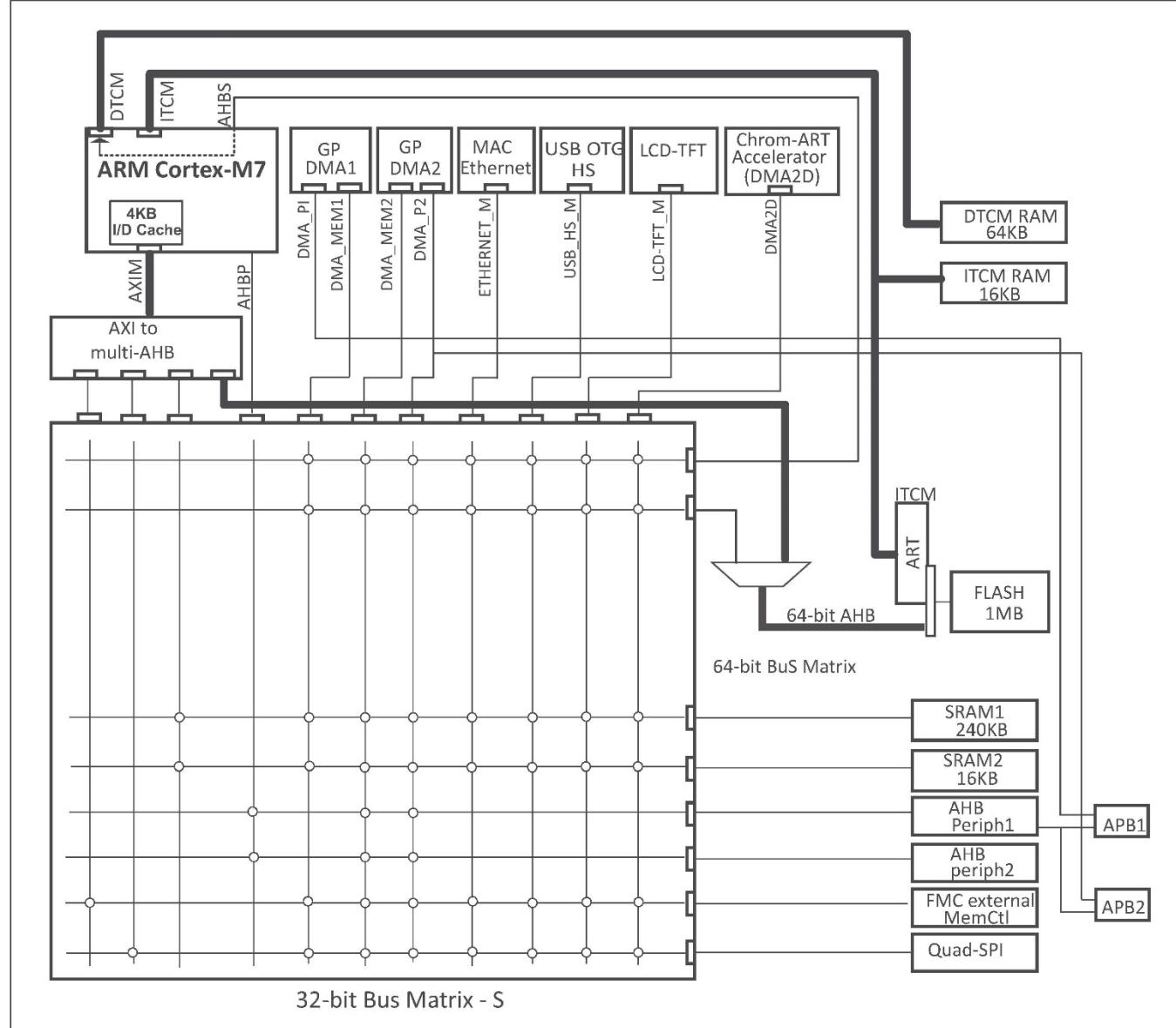


MSv3755ZV1

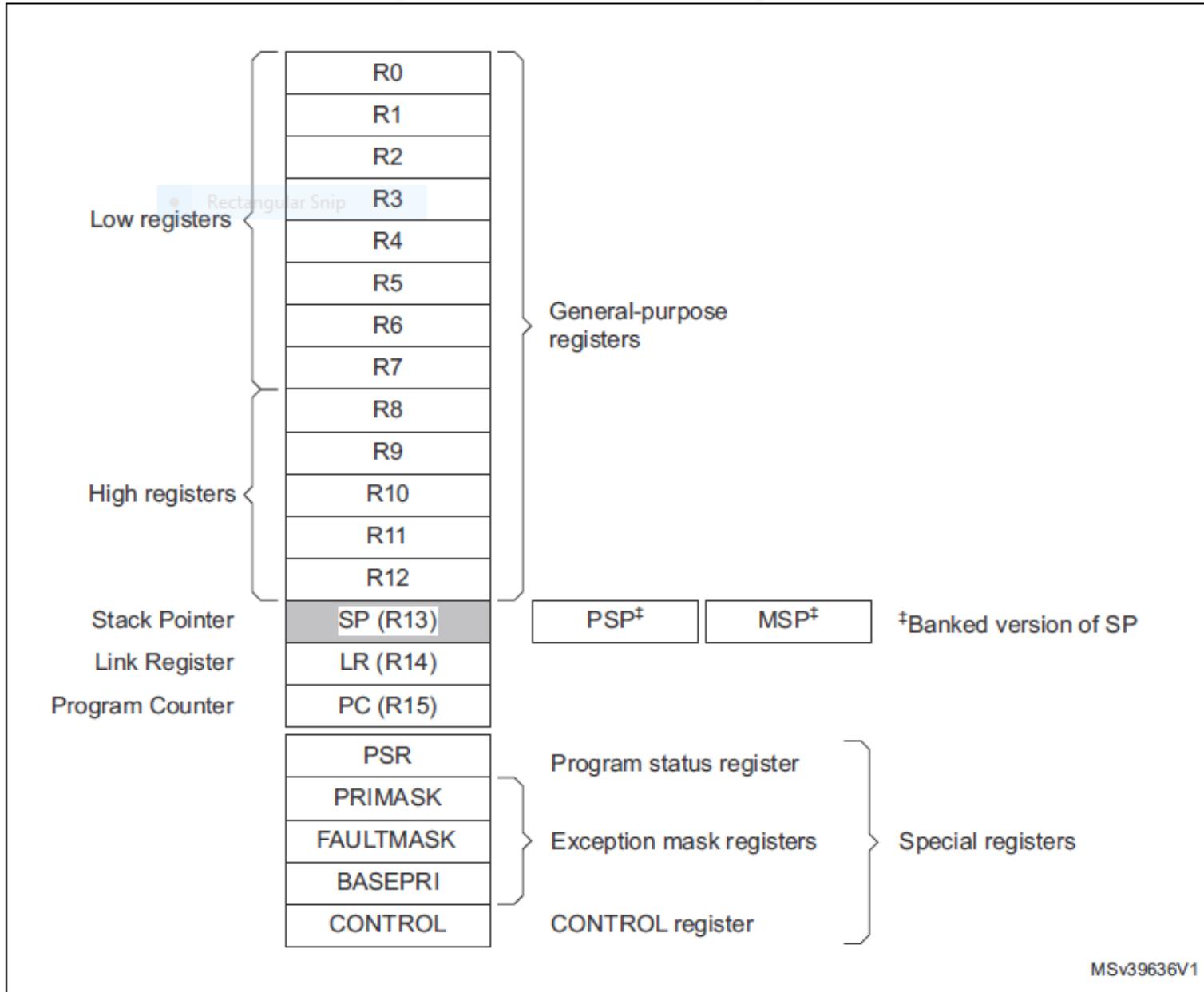
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# Bus Matrix

Figure 3. STM32F745xx and STM32F746xx AXI-AHB bus matrix architecture



**Figure 2. Processor core registers**



## Processor Core Registers

MSv39636V1

# Program Status Register

Figure 3. APSR, IPSR and EPSR bit assignments

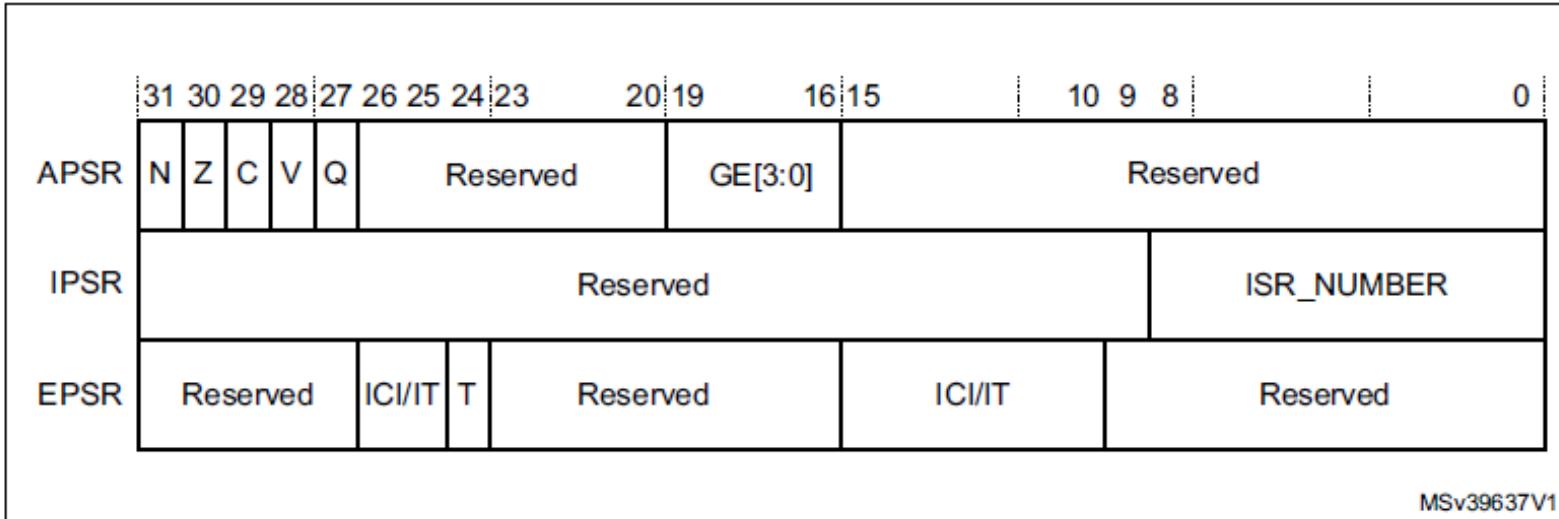


Table 4. APSR bit assignments

Bits	Name	Description
[31]	N	Negative flag.
[30]	Z	Zero flag.
[29]	C	Carry or borrow flag.
[28]	V	Overflow flag.

# Memory

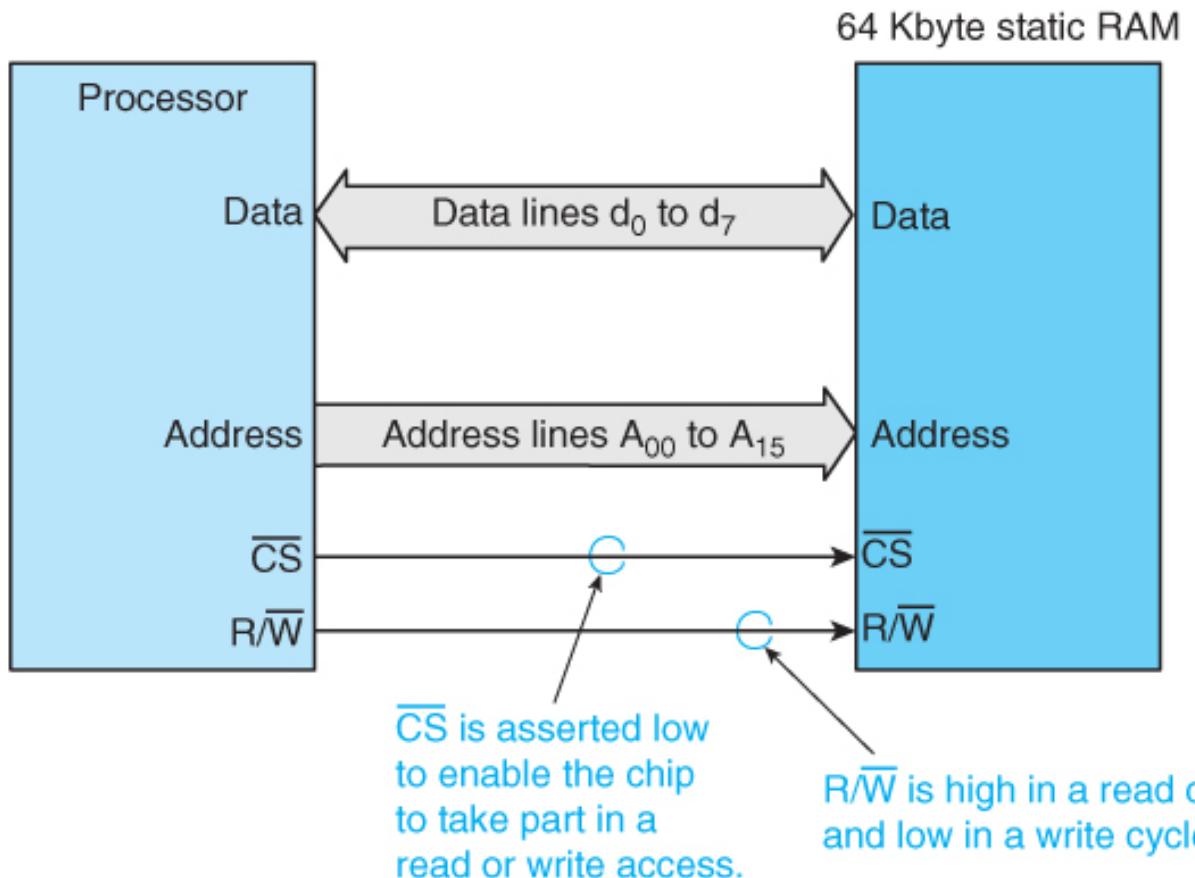
1. RAM (Random Access Memory)
  - Volatile
  - Static RAM (MOS/MOSFET)
  - Dynamic RAM (Capacitor)
  - Local Variable
2. ROM (Read Only Memory)
  - Nonvolatile
  - More complicated to write
  - Code + Constant

# Memory vs Application

Characteristic	DRAM	Static RAM	Flash memory
Static	No	Yes	Yes
Volatile	Yes	Yes	No
Typical size	256 Mbits	64 Mbits	256 Mbits
Organization	4 bits × 64 M	8 bits × 8 M	8 bits × 32 M
Access time	10 ns	2 ns	40 ns
Application	Main store	Cache memory	BIOS, digital film, MP3

# CPU & SRAM

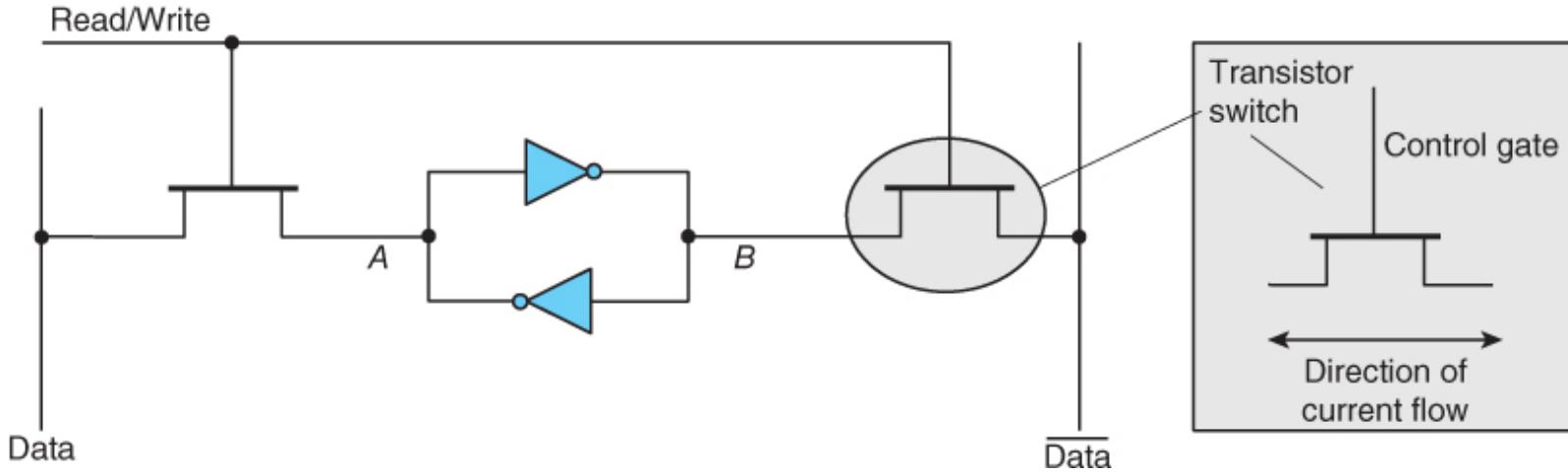
FIGURE 10.8 The static RAM chip



# SRAM Cell

FIGURE 10.5

Operation of the static RAM cell



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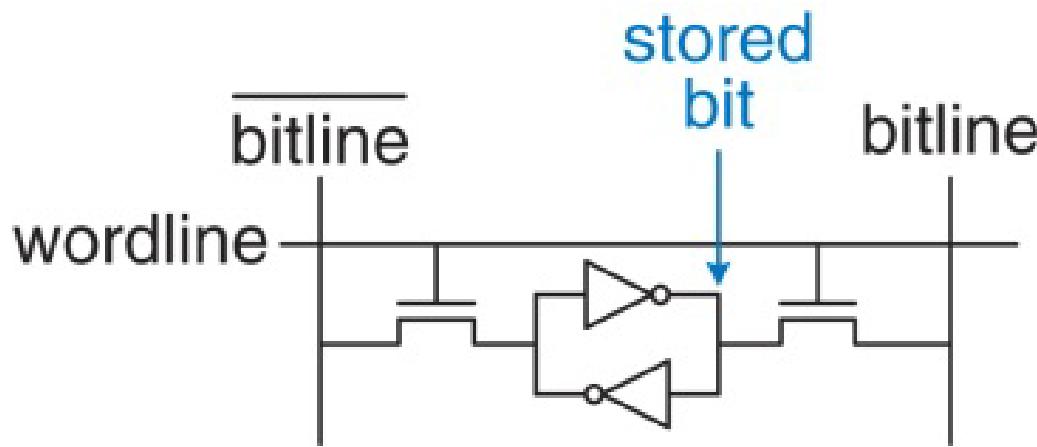
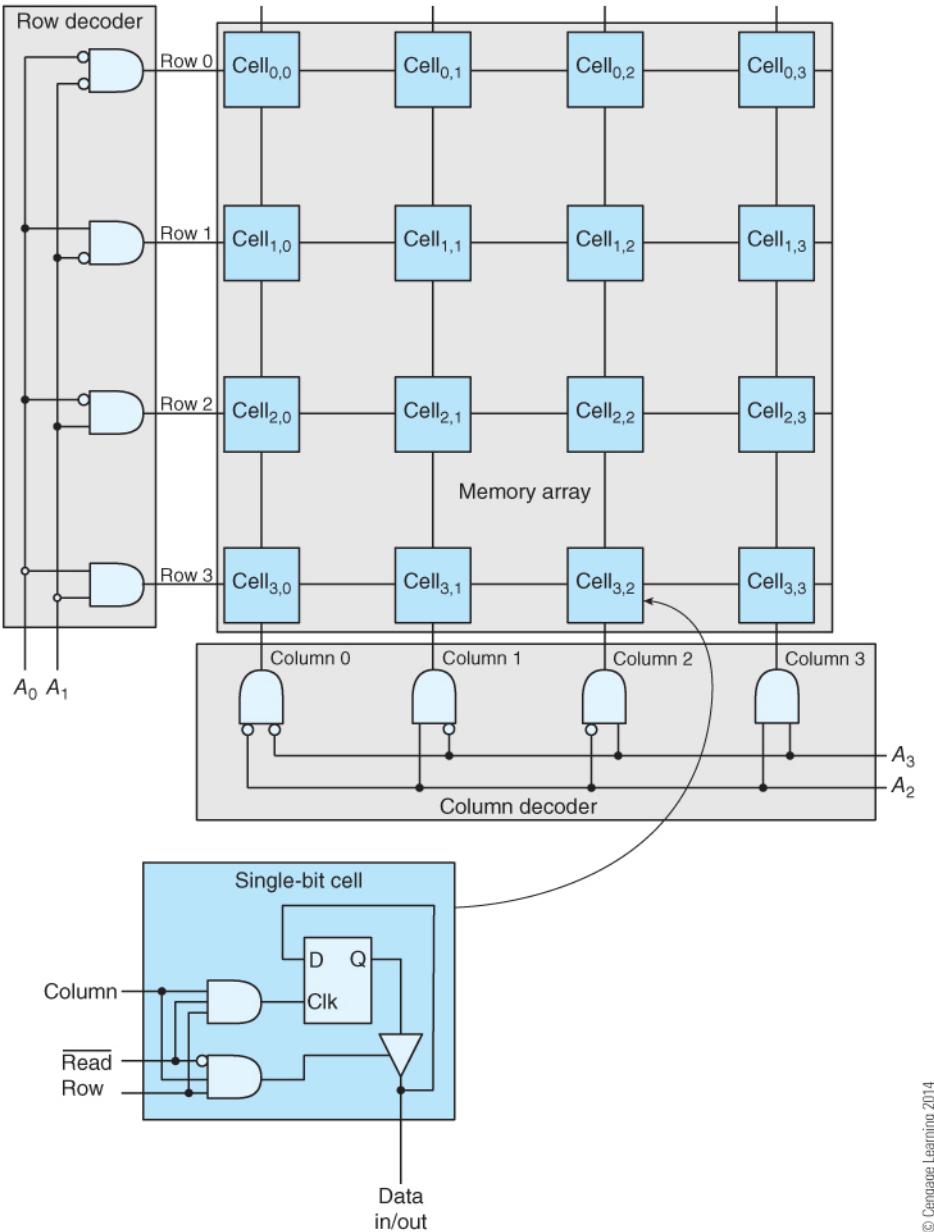


FIGURE 10.7 The arrangement of a static RAM array

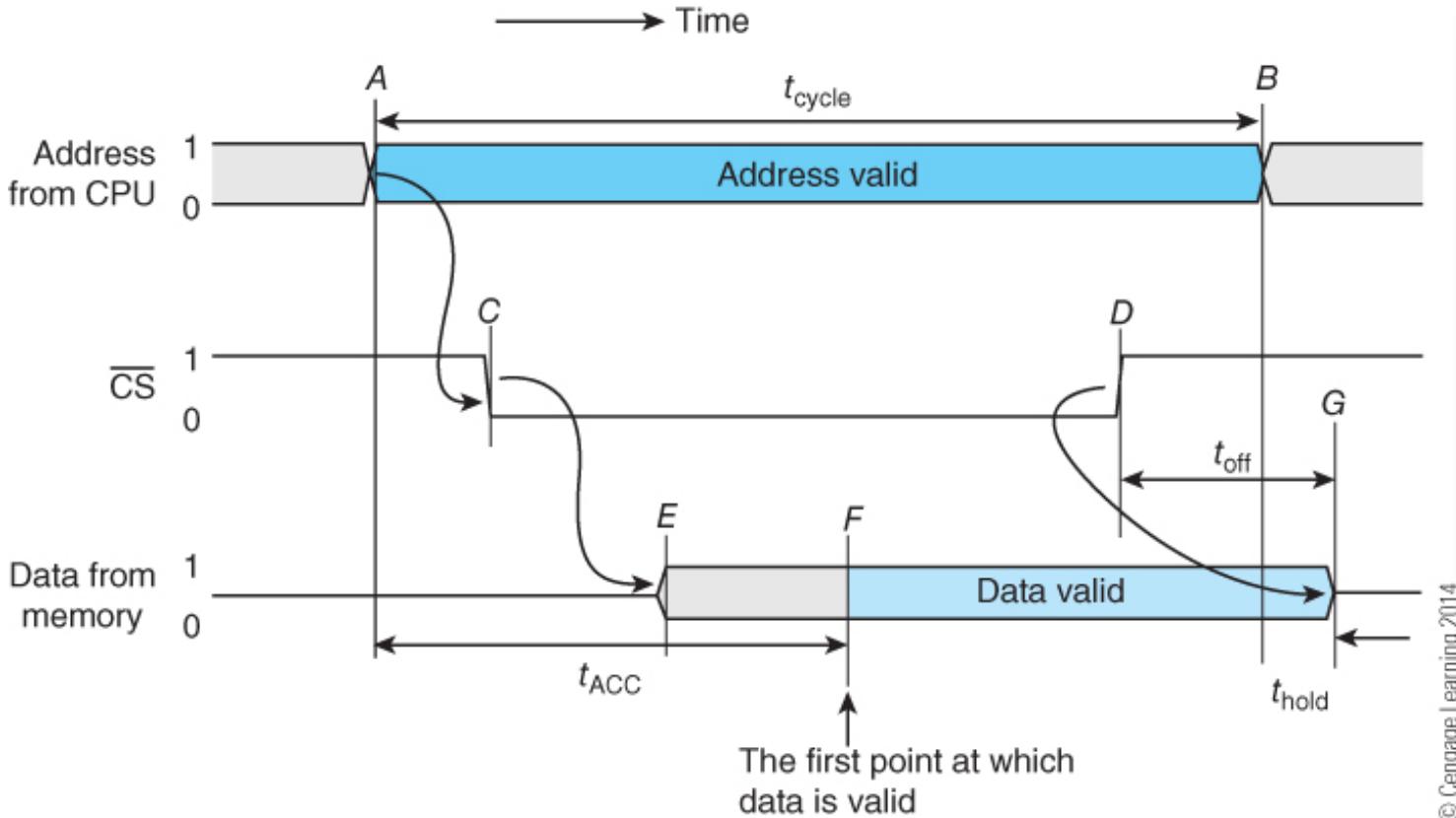


# SRAM Cell & Structure

# SRAM Read Cycle Timing

FIGURE 10.9

The static RAM read cycle timing diagram

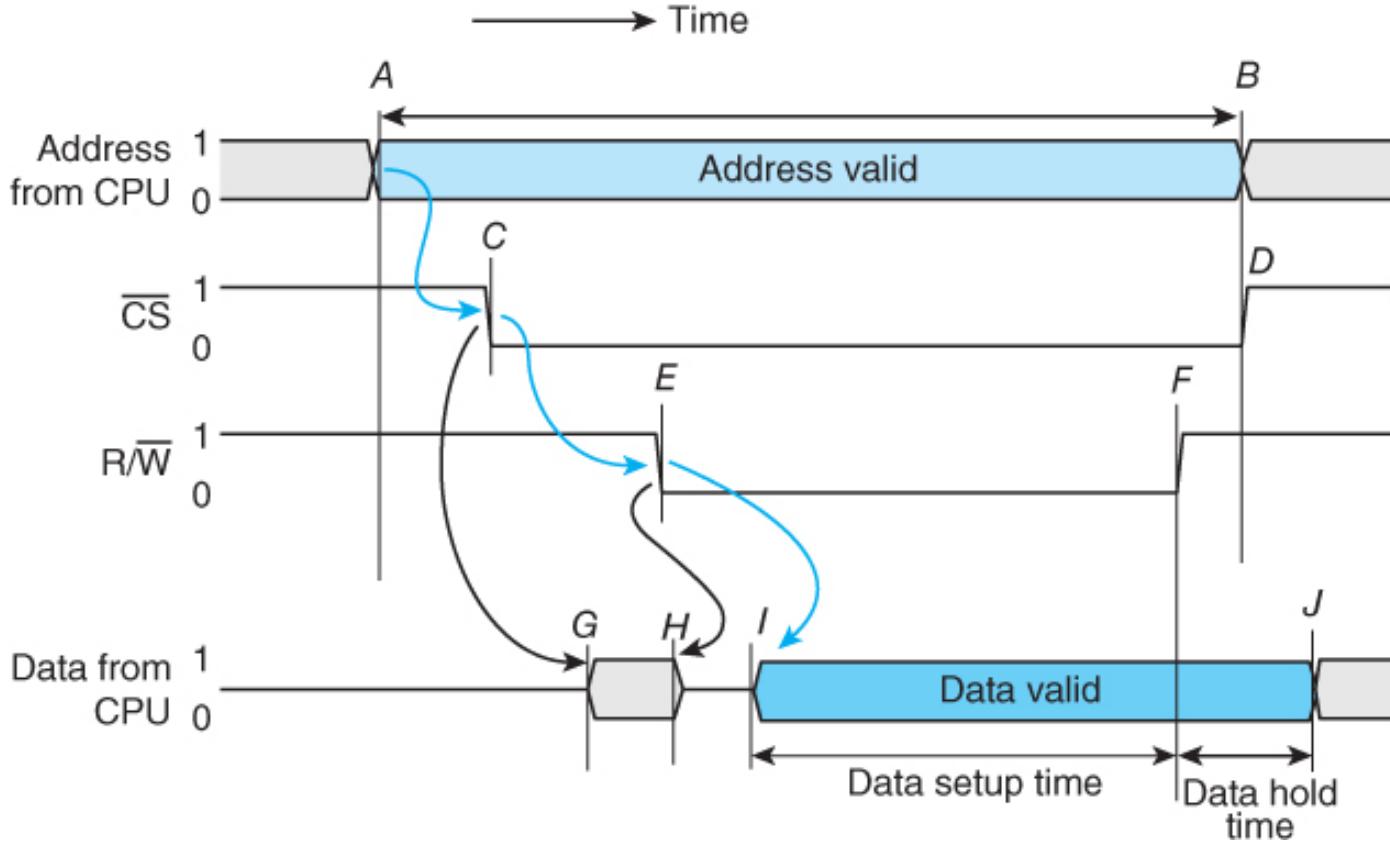


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# SRAM Write Cycle Timing

FIGURE 10.10

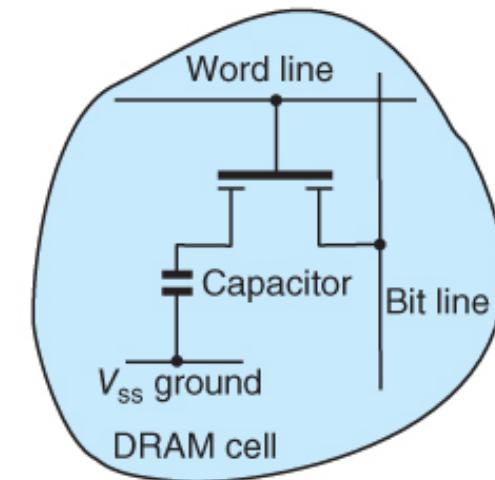
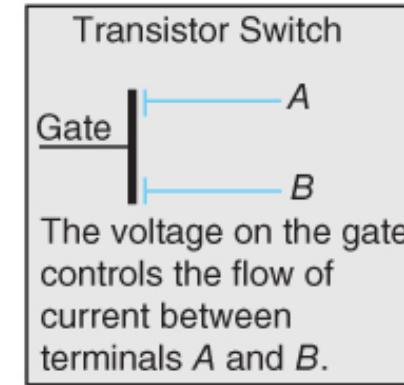
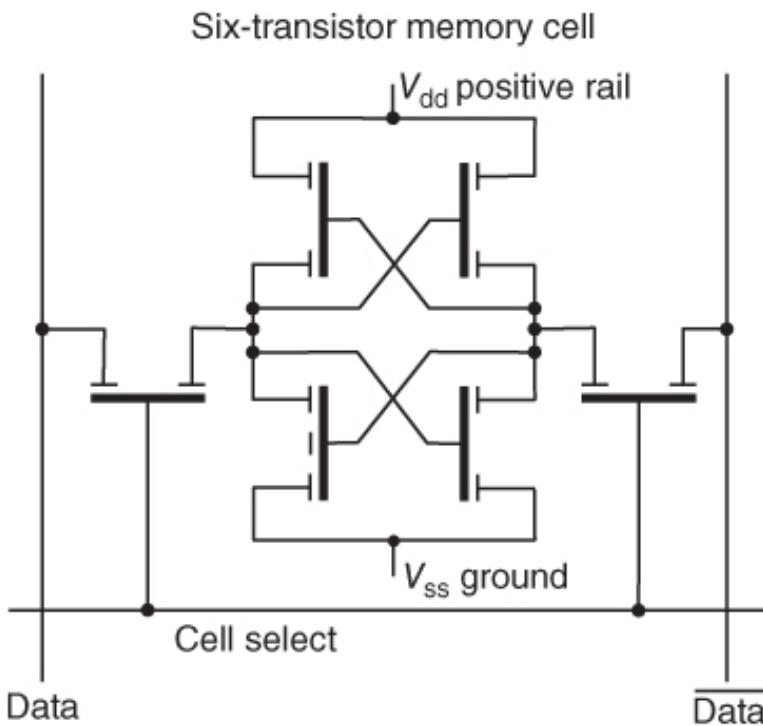
The static RAM write cycle timing diagram



# SRAM Cell

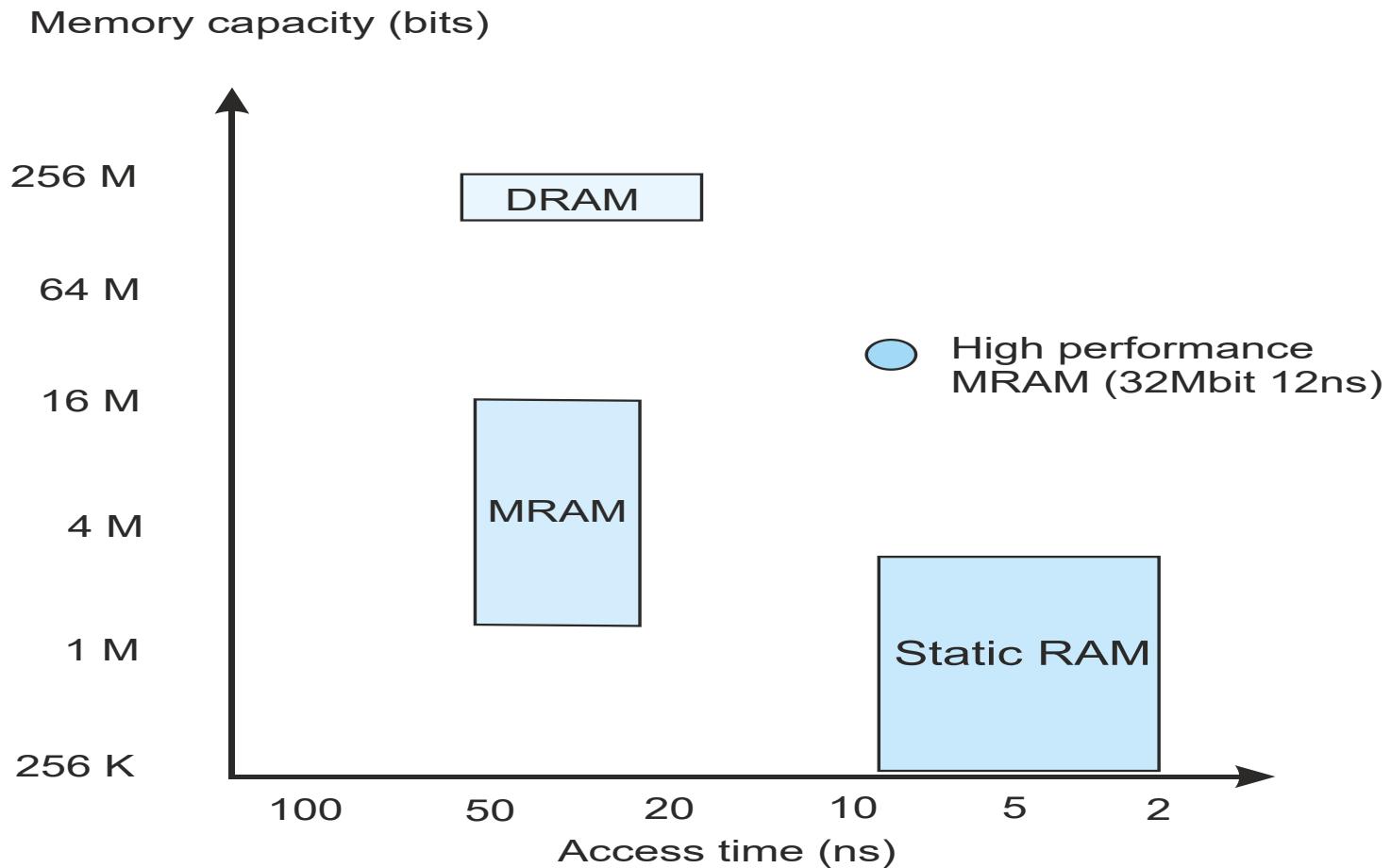
FIGURE 10.6

Circuit of the six-transistor static RAM cell with DRAM comparison



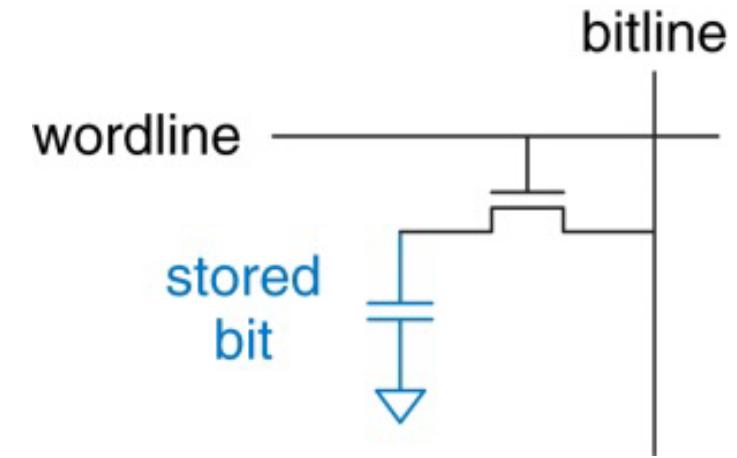
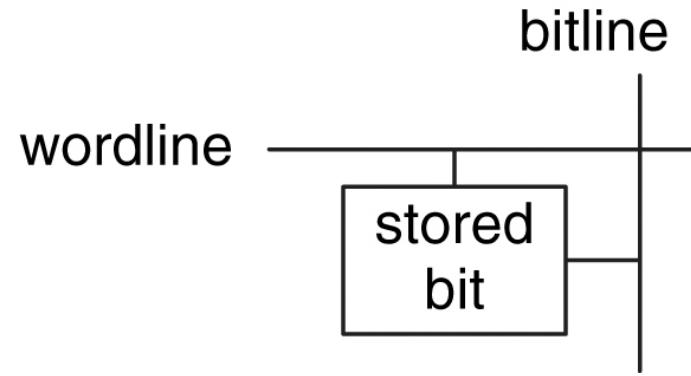
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# DRAM vs. SRAM Chip (Capacity & Time)

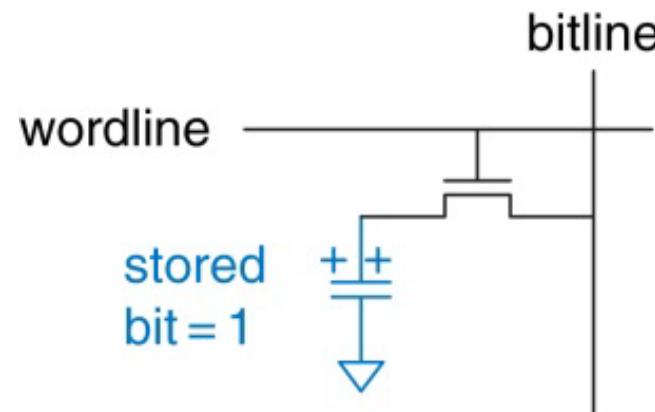


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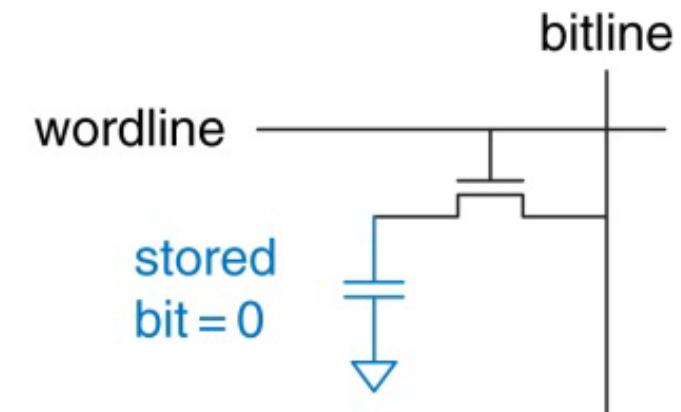
## DRAM Bit Cell



## DRAM Stored Values



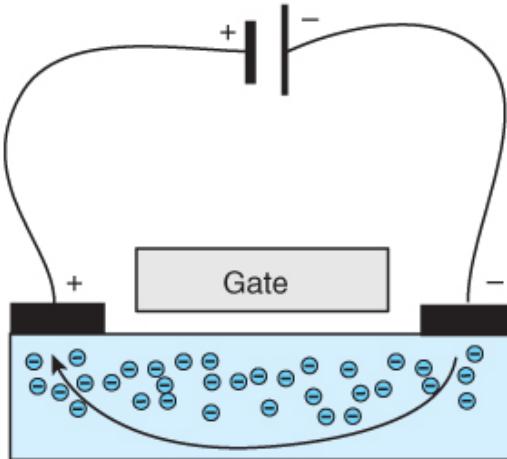
(a)



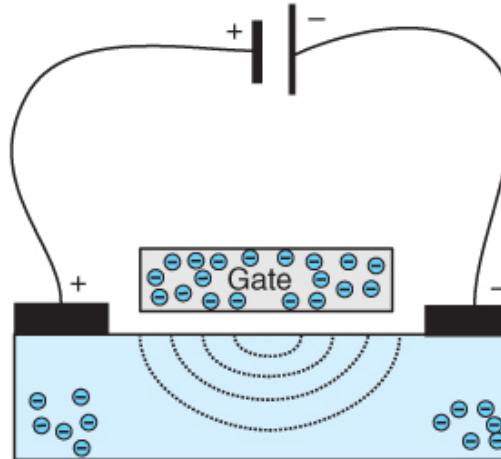
(b)

# DRAM Cell

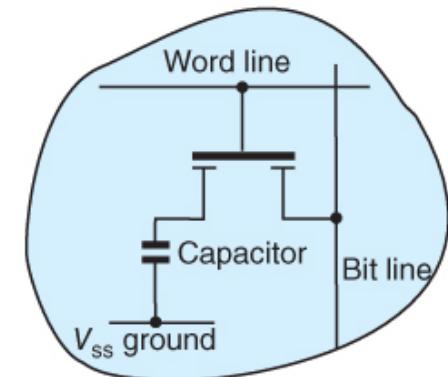
**FIGURE 10.16** The effect of a charged gate on electron flow



(a) No charge on gate



(b) Negative charge on gate

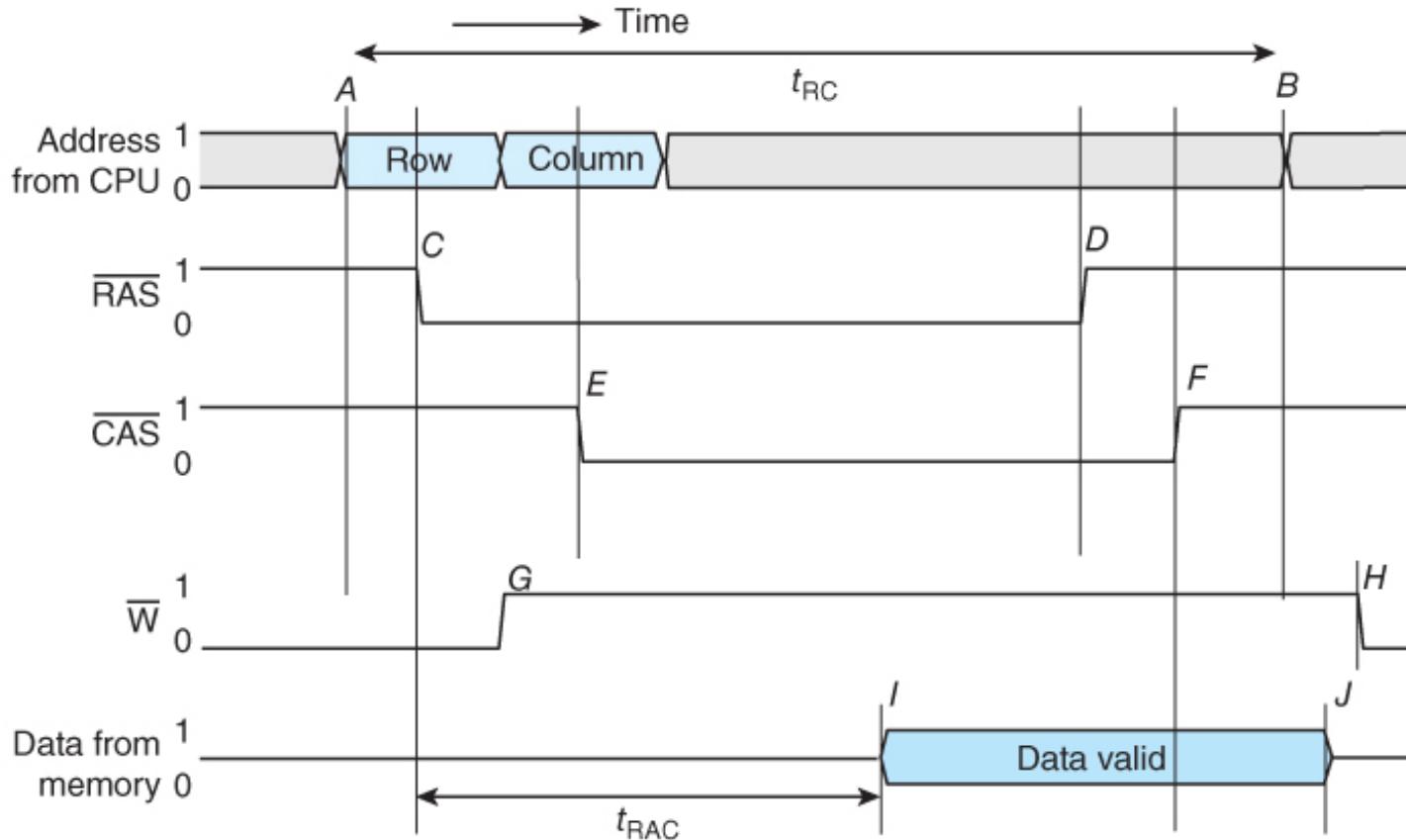


(c) DRAM cell

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# DRAM Read Cycle Timing

FIGURE 10.20 DRAM read cycle timing

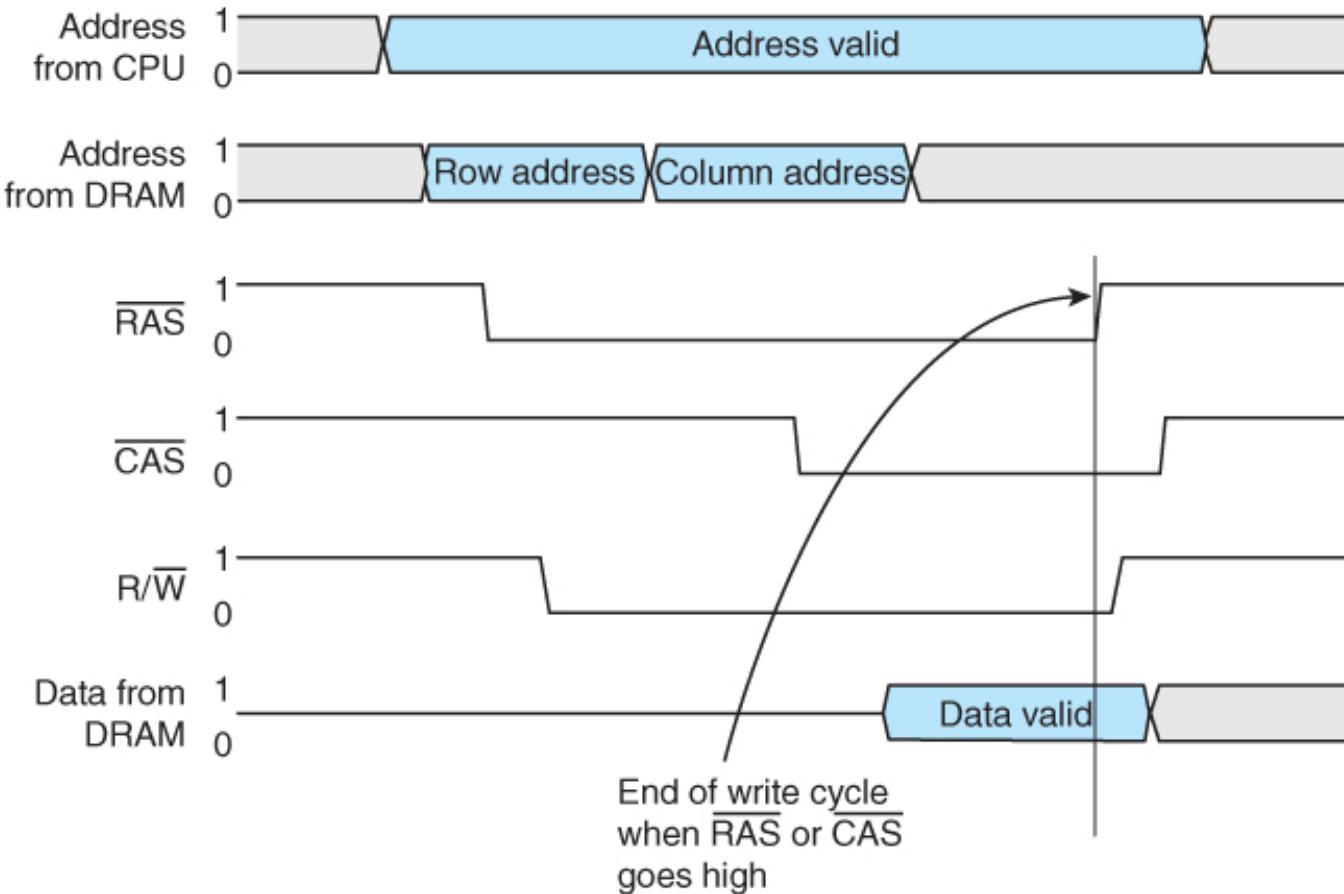


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# DRAM Write Cycle Timing

FIGURE 10.24

DRAM write cycle timing



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# DDR2-PC2-5300U 2GB 667-MHz DIMM (Dual Inline Memory Module)



# Summary

- Simple register made from D-FF
  - Stores digital bits
- Cortex M is Harvard architecture
- Cortex M has 16 registers
  - 13 general purpose registers
  - 3 special registers SP, LR and PC
- N Z C V flag of Program Status Register
- Memory
  - RAM
  - ROM